

## CMOS Hex Buffer/Converters

The CD4049UB and CD4050B devices are inverting and non-inverting hex buffers, respectively, and feature logic-level conversion using only one supply voltage ( $V_{CC}$ ). The input-signal high level ( $V_{IH}$ ) can exceed the  $V_{CC}$  supply voltage when these devices are used for logic-level conversions. These devices are intended for use as CMOS to DTL/TTL converters and can drive directly two DTL/TTL loads. ( $V_{CC} = 5V$ ,  $V_{OL} \leq 0.4V$ , and  $I_{OL} \geq 3.3mA$ .)

The CD4049UB and CD4050B are designated as replacements for CD4009UB and CD4010B, respectively. Because the CD4049UB and CD4050B require only one power supply, they are preferred over the CD4009UB and CD4010B and should be used in place of the CD4009UB and CD4010B in all inverter, current driver, or logic-level conversion applications. In these applications the CD4049UB and CD4050B are pin compatible with the CD4009UB and CD4010B respectively, and can be substituted for these devices in existing as well as in new designs. Terminal No. 16 is not connected internally on the CD4049UB or CD4050B, therefore, connection to this terminal is of no consequence to circuit operation. For applications not requiring high sink-current or voltage conversion, the CD4069UB Hex Inverter is recommended.

## Features

- CD4049UB Inverting
- CD4050B Non-Inverting
- High Sink Current for Driving 2 TTL Loads
- High-To-Low Level Logic Conversion
- 100% Tested for Quiescent Current at 20V
- Maximum Input Current of  $1\mu A$  at 18V Over Full Package Temperature Range; 100nA at 18V and 25°C
- 5V, 10V and 15V Parametric Ratings

## Applications

- CMOS to DTL/TTL Hex Converter
- CMOS Current "Sink" or "Source" Driver
- CMOS High-To-Low Logic Level Converter

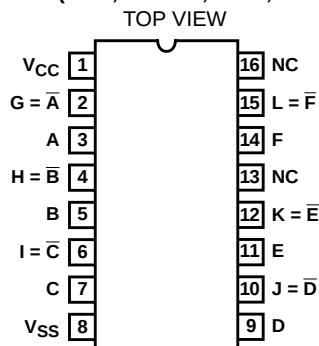
## Ordering Information

| PART NUMBER | TEMP. RANGE (°C) | PACKAGE      |
|-------------|------------------|--------------|
| CD4049UBF3A | -55 to 125       | 16 Ld Cerdip |
| CD4050BF3A  | -55 to 125       | 16 Ld Cerdip |
| CD4049UBD   | -55 to 125       | 16 Ld SOIC   |
| CD4049UBDR  | -55 to 125       | 16 Ld SOIC   |
| CD4049UBDT  | -55 to 125       | 16 Ld SOIC   |
| CD4049UBDW  | -55 to 125       | 16 Ld SOIC   |
| CD4049UBDWR | -55 to 125       | 16 Ld SOIC   |
| CD4049UBE   | -55 to 125       | 16 Ld PDIP   |
| CD4049UBNSR | -55 to 125       | 16 Ld SOP    |
| CD4049BPW   | -55 to 125       | 16 Ld TSSOP  |
| CD4049BPWR  | -55 to 125       | 16 Ld TSSOP  |
| CD4050BD    | -55 to 125       | 16 Ld SOIC   |
| CD4050BDR   | -55 to 125       | 16 Ld SOIC   |
| CD4050BDT   | -55 to 125       | 16 Ld SOIC   |
| CD4050BDW   | -55 to 125       | 16 Ld SOIC   |
| CD4050BDWR  | -55 to 125       | 16 Ld SOIC   |
| CD4050BE    | -55 to 125       | 16 Ld PDIP   |
| CD4050NSR   | -55 to 125       | 16 Ld SOP    |
| CD4050BPW   | -55 to 125       | 16 Ld TSSOP  |
| CD4050BPWR  | -55 to 125       | 16 Ld TSSOP  |

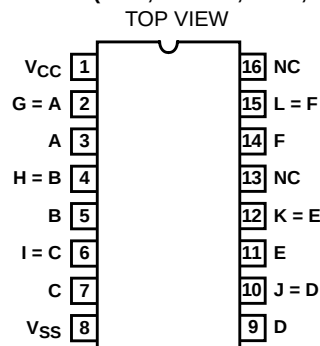
NOTE: When ordering, use the entire part number. The suffix R denotes tape and reel. The suffix T denotes a small-quantity reel of 250.

## Pinouts

CD4049UB (PDIP, Cerdip, SOIC, SOP, TSSOP)

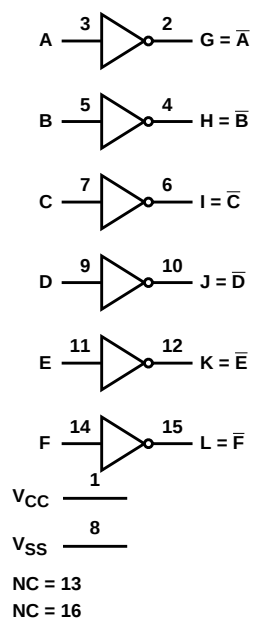


CD4050B (PDIP, Cerdip, SOIC, SOP)

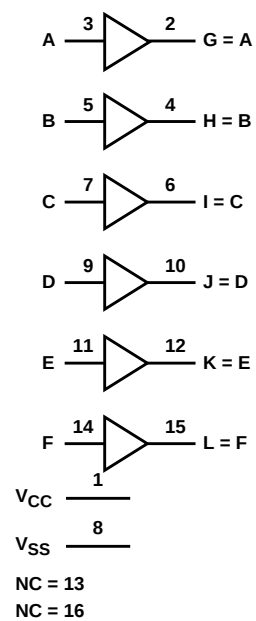


## Functional Block Diagrams

CD4049UB



CD4050B



## Schematic Diagrams

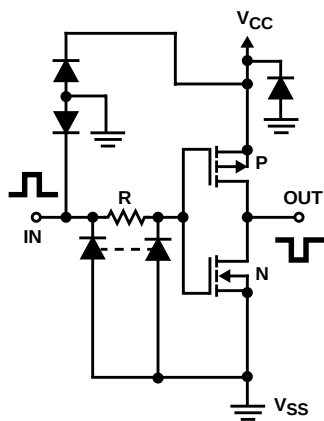


FIGURE 1A. SCHEMATIC DIAGRAM OF CD4049UB, 1 OF 6 IDENTICAL UNITS

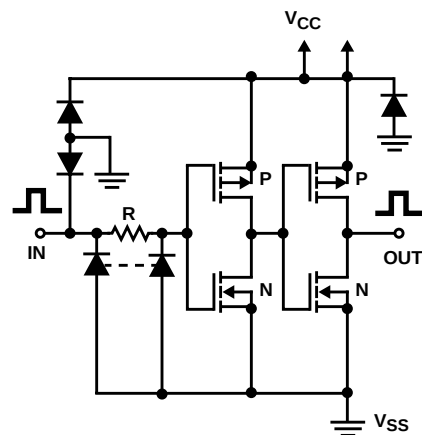


FIGURE 1B. SCHEMATIC DIAGRAM OF CD4050B, 1 OF 6 IDENTICAL UNITS

# CD4049UB, CD4050B

## Absolute Maximum Ratings

Supply Voltage (V+ to V-) . . . . . -0.5V to 20V  
DC Input Current, Any One Input. . . . .  $\pm 10\text{mA}$

## Operating Conditions

Temperature Range . . . . .  $-55^{\circ}\text{C}$  to  $125^{\circ}\text{C}$

## Thermal Information

Package Thermal Impedance,  $\theta_{JA}$  (see Note1):  
E (PDIP) Package . . . . .  $67^{\circ}\text{C/W}$   
D (SOIC) Package . . . . .  $73^{\circ}\text{C/W}$   
DW (SOIC) Package . . . . .  $57^{\circ}\text{C/W}$   
NS (SOP) Package . . . . .  $64^{\circ}\text{C/W}$   
PW (TSSOP) Package . . . . .  $108^{\circ}\text{C/W}$   
Maximum Junction Temperature (Plastic Package) . . . . .  $150^{\circ}\text{C}$   
Maximum Storage Temperature Range . . . . .  $65^{\circ}\text{C}$  to  $150^{\circ}\text{C}$   
Maximum Lead Temperature (Soldering 10s) . . . . .  $265^{\circ}\text{C}$   
SOIC - Lead Tips Only

**CAUTION:** Stresses above those listed in "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress only rating and operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.

### NOTE:

1. The package thermal impedance is calculated in accordance with JESD 51-7.

## DC Electrical Specifications

| PARAMETER                                             | TEST CONDITIONS       |                        |                     | LIMITS AT INDICATED TEMPERATURE (°C) |       |       |       |       |      |      | UNITS |
|-------------------------------------------------------|-----------------------|------------------------|---------------------|--------------------------------------|-------|-------|-------|-------|------|------|-------|
|                                                       |                       |                        |                     |                                      |       |       |       | 25    |      |      |       |
|                                                       | V <sub>O</sub><br>(V) | V <sub>IN</sub><br>(V) | V <sub>CC</sub> (V) |                                      |       |       |       | -55   | -40  | 85   |       |
| Quiescent Device Current<br>I <sub>DD</sub> (Max)     | -                     | 0,5                    | 5                   | 1                                    | 1     | 30    | 30    | -     | 0.02 | 1    | μA    |
|                                                       | -                     | 0,10                   | 10                  | 2                                    | 2     | 60    | 60    | -     | 0.02 | 2    | μA    |
|                                                       | -                     | 0,15                   | 15                  | 4                                    | 4     | 120   | 120   | -     | 0.02 | 4    | μA    |
|                                                       | -                     | 0,20                   | 20                  | 20                                   | 20    | 600   | 600   | -     | 0.04 | 20   | μA    |
| Output Low (Sink) Current<br>I <sub>OL</sub> (Min)    | 0.4                   | 0,5                    | 4.5                 | 3.3                                  | 3.1   | 2.1   | 1.8   | 2.6   | 5.2  | -    | mA    |
|                                                       | 0.4                   | 0,5                    | 5                   | 4                                    | 3.8   | 2.9   | 2.4   | 3.2   | 6.4  | -    | mA    |
|                                                       | 0.5                   | 0,10                   | 10                  | 10                                   | 9.6   | 6.6   | 5.6   | 8     | 16   | -    | mA    |
|                                                       | 1.5                   | 0,15                   | 15                  | 26                                   | 25    | 20    | 18    | 24    | 48   | -    | mA    |
| Output High (Source) Current<br>I <sub>OH</sub> (Min) | 4.6                   | 0,5                    | 5                   | -0.81                                | -0.73 | -0.58 | -0.48 | -0.65 | -1.2 | -    | mA    |
|                                                       | 2.5                   | 0,5                    | 5                   | -2.6                                 | -2.4  | -1.9  | -1.55 | -2.1  | -3.9 | -    | mA    |
|                                                       | 9.5                   | 0,10                   | 10                  | -2.0                                 | -1.8  | -1.35 | -1.18 | -1.65 | -3.0 | -    | mA    |
|                                                       | 13.5                  | 0,15                   | 15                  | -5.2                                 | -4.8  | -3.5  | -3.1  | -4.3  | -8.0 | -    | mA    |
| Out Voltage Low Level<br>V <sub>OL</sub> (Max)        | -                     | 0,5                    | 5                   | 0.05                                 | 0.05  | 0.05  | 0.05  | -     | 0    | 0.05 | V     |
|                                                       | -                     | 0,10                   | 10                  | 0.05                                 | 0.05  | 0.05  | 0.05  | -     | 0    | 0.05 | V     |
|                                                       | -                     | 0,15                   | 15                  | 0.05                                 | 0.05  | 0.05  | 0.05  | -     | 0    | 0.05 | V     |
| Output Voltage High Level<br>V <sub>OH</sub> (Min)    | -                     | 0,5                    | 5                   | 4.95                                 | 4.95  | 4.95  | 4.95  | 4.95  | 5    | -    | V     |
|                                                       | -                     | 0,10                   | 10                  | 9.95                                 | 9.95  | 9.95  | 9.95  | 9.95  | 10   | -    | V     |
|                                                       | -                     | 0,15                   | 15                  | 14.95                                | 14.95 | 14.95 | 14.95 | 14.95 | 15   | -    | V     |
| Input Low Voltage, V <sub>IL</sub> (Max)<br>CD4049UB  | 4.5                   | -                      | 5                   | 1                                    | 1     | 1     | 1     | -     | -    | 1    | V     |
|                                                       | 9                     | -                      | 10                  | 2                                    | 2     | 2     | 2     | -     | -    | 2    | V     |
|                                                       | 13.5                  | -                      | 15                  | 2.5                                  | 2.5   | 2.5   | 2.5   | -     | -    | 2.5  | V     |
| Input Low Voltage, V <sub>IL</sub> (Max)<br>CD4050B   | 0.5                   | -                      | 5                   | 1.5                                  | 1.5   | 1.5   | 1.5   | -     | -    | 1.5  | V     |
|                                                       | 1                     | -                      | 10                  | 3                                    | 3     | 3     | 3     | -     | -    | 3    | V     |
|                                                       | 1.5                   | -                      | 15                  | 4                                    | 4     | 4     | 4     | -     | -    | 4    | V     |

# CD4049UB, CD4050B

## DC Electrical Specifications (Continued)

| PARAMETER                                           | TEST CONDITIONS    |                     |                     | LIMITS AT INDICATED TEMPERATURE (°C) |      |      |      |      |                   |      | UNITS |
|-----------------------------------------------------|--------------------|---------------------|---------------------|--------------------------------------|------|------|------|------|-------------------|------|-------|
|                                                     |                    |                     |                     |                                      |      |      |      | 25   |                   |      |       |
|                                                     | V <sub>O</sub> (V) | V <sub>IN</sub> (V) | V <sub>CC</sub> (V) |                                      |      |      |      | -55  | -40               | 85   |       |
| Input High Voltage, V <sub>IH</sub> Min<br>CD4049UB | 0.5                | -                   | 5                   | 4                                    | 4    | 4    | 4    | 4    | -                 | -    | V     |
|                                                     | 1                  | -                   | 10                  | 8                                    | 8    | 8    | 8    | 8    | -                 | -    | V     |
|                                                     | 1.5                | -                   | 15                  | 12.5                                 | 12.5 | 12.5 | 12.5 | 12.5 | -                 | -    | V     |
| Input High Voltage, V <sub>IH</sub> Min<br>CD4050B  | 4.5                | -                   | 5                   | 3.5                                  | 3.5  | 3.5  | 3.5  | 3.5  | -                 | -    | V     |
|                                                     | 9                  | -                   | 10                  | 7                                    | 7    | 7    | 7    | 7    | -                 | -    | V     |
|                                                     | 13.5               | -                   | 15                  | 11                                   | 11   | 11   | 11   | 11   | -                 | -    | V     |
| Input Current, I <sub>IN</sub> Max                  | -                  | 0,18                | 18                  | ±0.1                                 | ±0.1 | ±1   | ±1   | -    | ±10 <sup>-5</sup> | ±0.1 | µA    |

## AC Electrical Specifications T<sub>A</sub> = 25°C, Input t<sub>r</sub>, t<sub>f</sub> = 20ns, C<sub>L</sub> = 50pF, R<sub>L</sub> = 200kΩ

| PARAMETER                                                           | TEST CONDITIONS |                 | LIMITS (ALL PACKAGES) |     | UNITS |
|---------------------------------------------------------------------|-----------------|-----------------|-----------------------|-----|-------|
|                                                                     | V <sub>IN</sub> | V <sub>CC</sub> | TYP                   | MAX |       |
| Propagation Delay Time<br>Low to High, t <sub>PLH</sub><br>CD4049UB | 5               | 5               | 60                    | 120 | ns    |
|                                                                     | 10              | 10              | 32                    | 65  | ns    |
|                                                                     | 10              | 5               | 45                    | 90  | ns    |
|                                                                     | 15              | 15              | 25                    | 50  | ns    |
|                                                                     | 15              | 5               | 45                    | 90  | ns    |
| Propagation Delay Time<br>Low to High, t <sub>PLH</sub><br>CD4050B  | 5               | 5               | 70                    | 140 | ns    |
|                                                                     | 10              | 10              | 40                    | 80  | ns    |
|                                                                     | 10              | 5               | 45                    | 90  | ns    |
|                                                                     | 15              | 15              | 30                    | 60  | ns    |
|                                                                     | 15              | 5               | 40                    | 80  | ns    |
| Propagation Delay Time<br>High to Low, t <sub>PHL</sub><br>CD4049UB | 5               | 5               | 32                    | 65  | ns    |
|                                                                     | 10              | 10              | 20                    | 40  | ns    |
|                                                                     | 10              | 5               | 15                    | 30  | ns    |
|                                                                     | 15              | 15              | 15                    | 30  | ns    |
|                                                                     | 15              | 5               | 10                    | 20  | ns    |
| Propagation Delay Time<br>High to Low, t <sub>PHL</sub><br>CD4050B  | 5               | 5               | 55                    | 110 | ns    |
|                                                                     | 10              | 10              | 22                    | 55  | ns    |
|                                                                     | 10              | 5               | 50                    | 100 | ns    |
|                                                                     | 15              | 15              | 15                    | 30  | ns    |
|                                                                     | 15              | 5               | 50                    | 100 | ns    |
| Transition Time, Low to High, t <sub>TLH</sub>                      | 5               | 5               | 80                    | 160 | ns    |
|                                                                     | 10              | 10              | 40                    | 80  | ns    |
|                                                                     | 15              | 15              | 30                    | 60  | ns    |
| Transition Time, High to Low, t <sub>THL</sub>                      | 5               | 5               | 30                    | 60  | ns    |
|                                                                     | 10              | 10              | 20                    | 40  | ns    |
|                                                                     | 15              | 15              | 15                    | 30  | ns    |

# CD4049UB, CD4050B

## AC Electrical Specifications $T_A = 25^\circ\text{C}$ , Input $t_r, t_f = 20\text{ns}$ , $C_L = 50\text{pF}$ , $R_L = 200\text{k}\Omega$ (Continued)

| PARAMETER                               | TEST CONDITIONS |          | LIMITS (ALL PACKAGES) |      | UNITS |
|-----------------------------------------|-----------------|----------|-----------------------|------|-------|
|                                         | $V_{IN}$        | $V_{CC}$ | TYP                   | MAX  |       |
| Input Capacitance, $C_{IN}$<br>CD4049UB | -               | -        | 15                    | 22.5 | pF    |
| Input Capacitance, $C_{IN}$<br>CD4050B  | -               | -        | 5                     | 7.5  | pF    |

## Typical Performance Curves

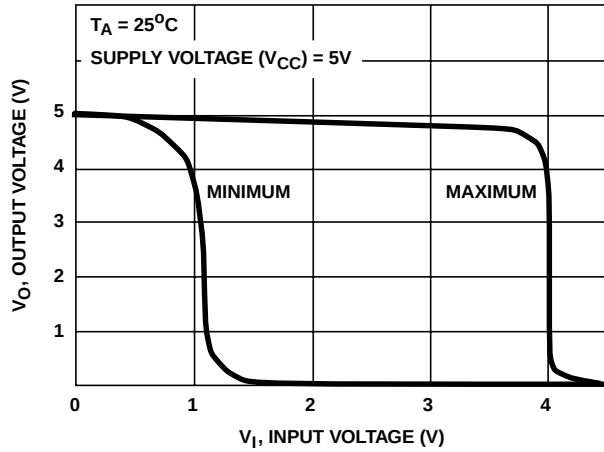


FIGURE 2. MINIMUM AND MAXIMUM VOLTAGE TRANSFER CHARACTERISTICS FOR CD4049UB

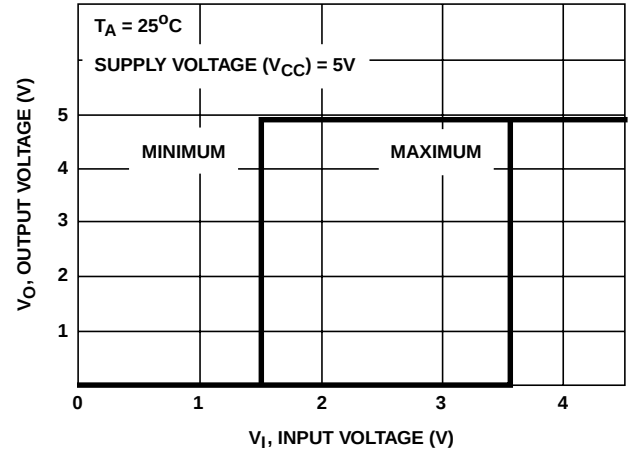


FIGURE 3. MINIMUM AND MAXIMUM VOLTAGE TRANSFER CHARACTERISTICS FOR CD4050B

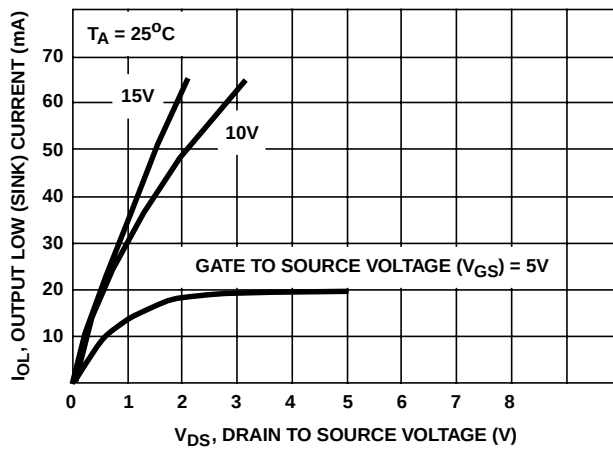


FIGURE 4. TYPICAL OUTPUT LOW (SINK) CURRENT CHARACTERISTICS

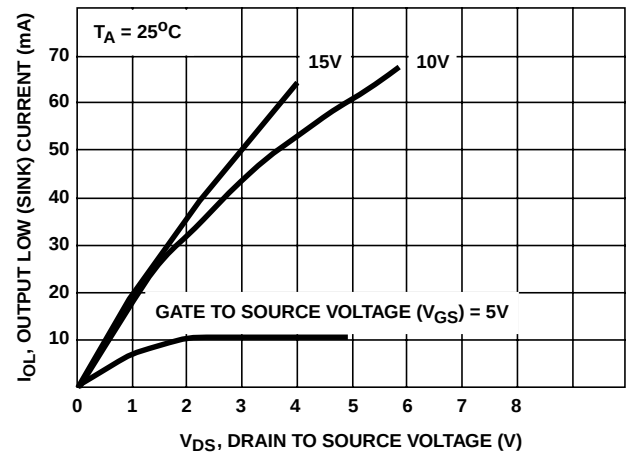


FIGURE 5. MINIMUM OUTPUT LOW (SINK) CURRENT DRAIN CHARACTERISTICS

Typical Performance Curves (Continued)

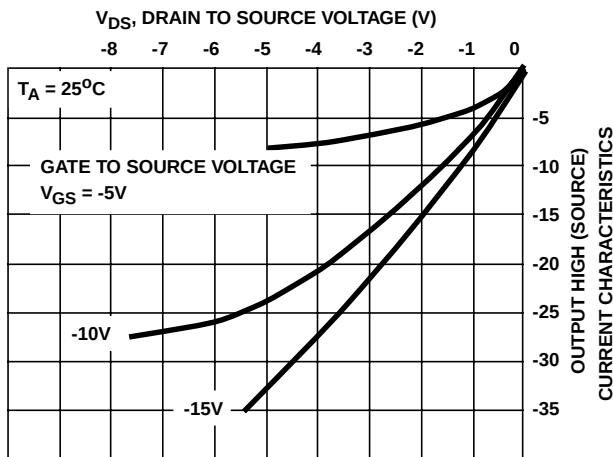


FIGURE 6. TYPICAL OUTPUT HIGH (SOURCE) CURRENT CHARACTERISTICS

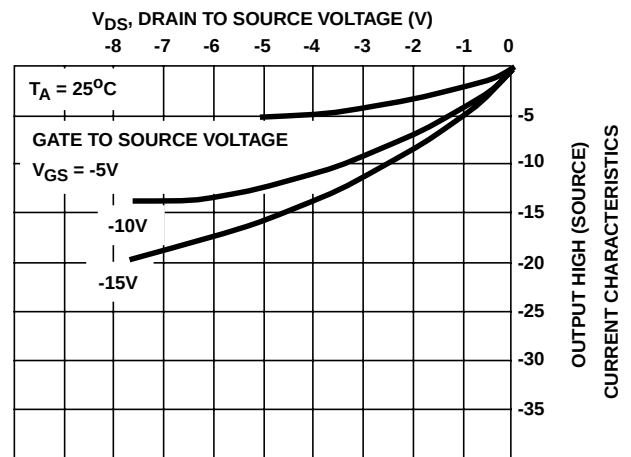


FIGURE 7. MINIMUM OUTPUT HIGH (SOURCE) CURRENT CHARACTERISTICS

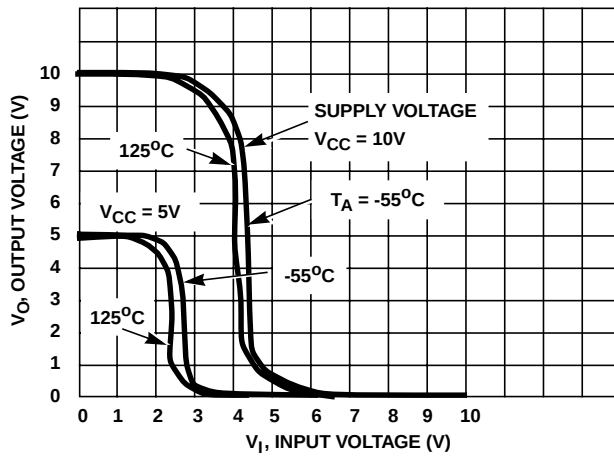


FIGURE 8. TYPICAL VOLTAGE TRANSFER CHARACTERISTICS AS A FUNCTION OF TEMPERATURE FOR CD4049UB

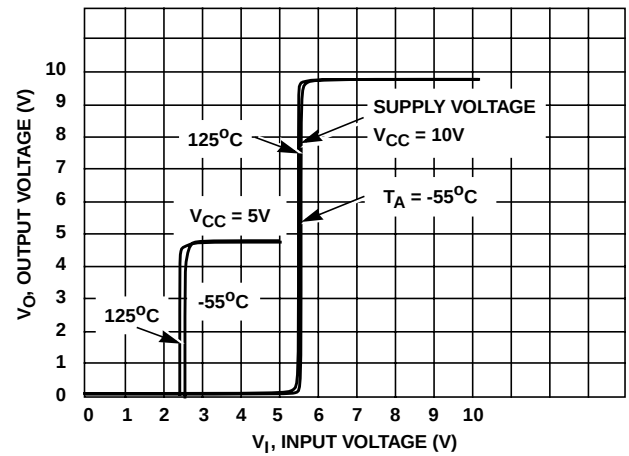


FIGURE 9. TYPICAL VOLTAGE TRANSFER CHARACTERISTICS AS A FUNCTION OF TEMPERATURE FOR CD4050B

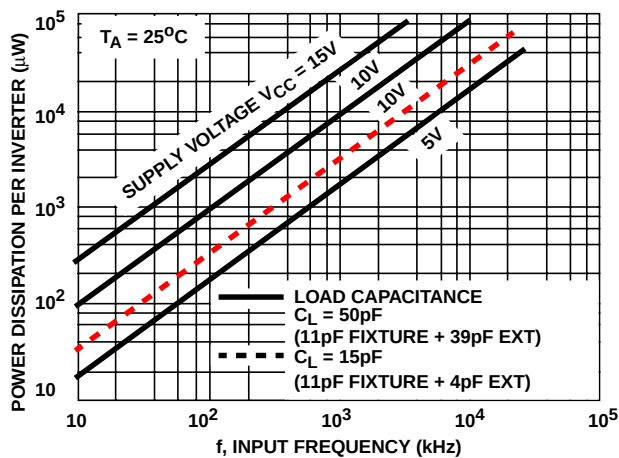


FIGURE 10. TYPICAL POWER DISSIPATION vs FREQUENCY CHARACTERISTICS

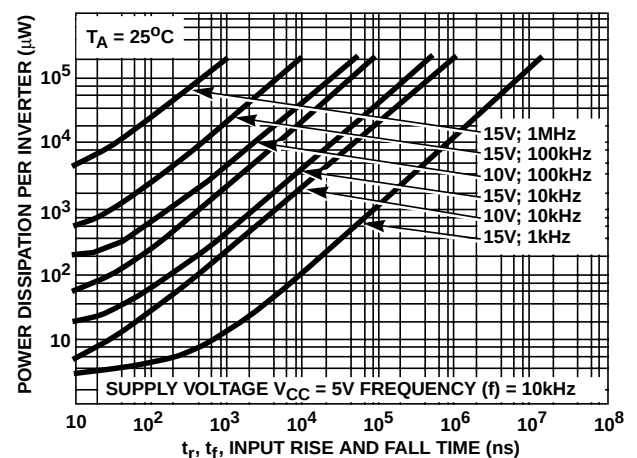


FIGURE 11. TYPICAL POWER DISSIPATION vs INPUT RISE AND FALL TIMES PER INVERTER FOR CD4049UB

## Typical Performance Curves (Continued)

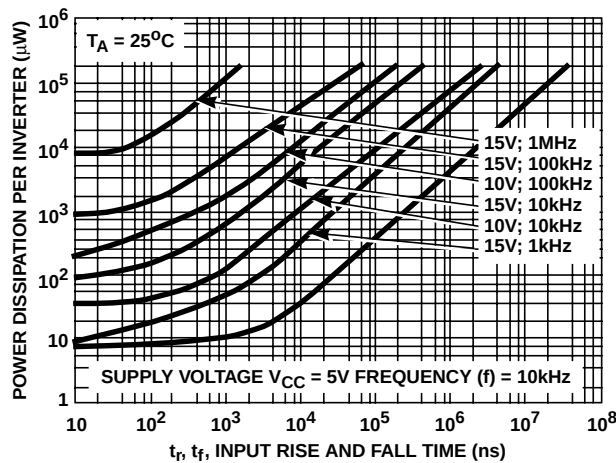


FIGURE 12. TYPICAL POWER DISSIPATION vs INPUT RISE AND FALL TIMES PER INVERTER FOR CD4050B

## Test Circuits

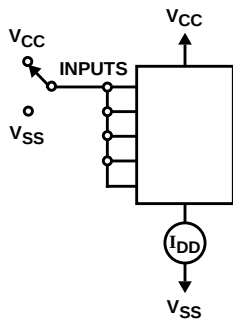
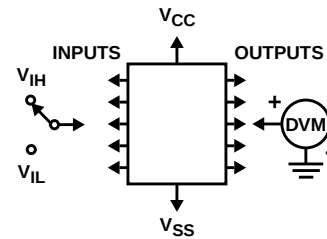
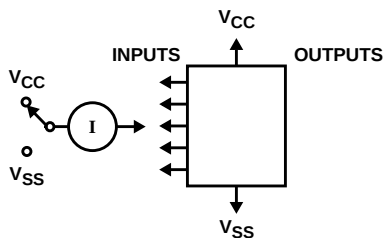


FIGURE 13. QUIESCENT DEVICE CURRENT TEST CIRCUIT



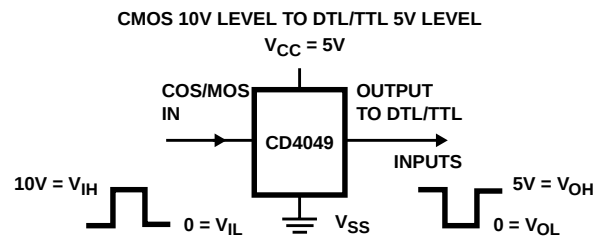
NOTE: Test any one input with other inputs at  $V_{CC}$  or  $V_{SS}$ .

FIGURE 14. INPUT VOLTAGE TEST CIRCUIT



NOTE: Measure inputs sequentially, to both  $V_{CC}$  and  $V_{SS}$  connect all unused inputs to either  $V_{CC}$  or  $V_{SS}$ .

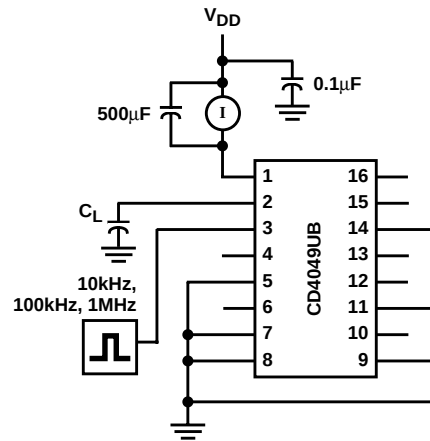
FIGURE 15. INPUT CURRENT TEST CIRCUIT



In Terminal - 3, 5, 7, 9, 11, or 14  
Out Terminal - 2, 4, 6, 10, 12 or 15  
 $V_{CC}$  Terminal - 1  
 $V_{SS}$  Terminal - 8

FIGURE 16. LOGIC LEVEL CONVERSION APPLICATION

**Test Circuits** (Continued)



$C_L$  INCLUDES FIXTURE CAPACITANCE

FIGURE 17. DYNAMIC POWER DISSIPATION TEST CIRCUITS



**PACKAGING INFORMATION**

| Orderable Device | Status <sup>(1)</sup> | Package Type | Package Drawing | Pins | Package Qty | Eco Plan <sup>(2)</sup> | Lead/Ball Finish | MSL Peak Temp <sup>(3)</sup> |
|------------------|-----------------------|--------------|-----------------|------|-------------|-------------------------|------------------|------------------------------|
| CD4049UBD        | ACTIVE                | SOIC         | D               | 16   | 40          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD4049UBDE4      | ACTIVE                | SOIC         | D               | 16   | 40          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD4049UBDG4      | ACTIVE                | SOIC         | D               | 16   | 40          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD4049UBDR       | ACTIVE                | SOIC         | D               | 16   | 2500        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD4049UBDRE4     | ACTIVE                | SOIC         | D               | 16   | 2500        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD4049UBDRG4     | ACTIVE                | SOIC         | D               | 16   | 2500        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD4049UBDT       | ACTIVE                | SOIC         | D               | 16   | 250         | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD4049UBDTE4     | ACTIVE                | SOIC         | D               | 16   | 250         | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD4049UBDTG4     | ACTIVE                | SOIC         | D               | 16   | 250         | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD4049UBDW       | ACTIVE                | SOIC         | DW              | 16   | 40          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD4049UBDWE4     | ACTIVE                | SOIC         | DW              | 16   | 40          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD4049UBDWG4     | ACTIVE                | SOIC         | DW              | 16   | 40          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD4049UBDWR      | ACTIVE                | SOIC         | DW              | 16   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD4049UBDWRE4    | ACTIVE                | SOIC         | DW              | 16   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD4049UBDWRG4    | ACTIVE                | SOIC         | DW              | 16   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD4049UBE        | ACTIVE                | PDIP         | N               | 16   | 25          | Pb-Free (RoHS)          | CU NIPDAU        | N / A for Pkg Type           |
| CD4049UBEE4      | ACTIVE                | PDIP         | N               | 16   | 25          | Pb-Free (RoHS)          | CU NIPDAU        | N / A for Pkg Type           |
| CD4049UBF        | ACTIVE                | CDIP         | J               | 16   | 1           | TBD                     | A42              | N / A for Pkg Type           |
| CD4049UBF3A      | ACTIVE                | CDIP         | J               | 16   | 1           | TBD                     | A42              | N / A for Pkg Type           |
| CD4049UBF3AS2283 | OBSOLETE              | CDIP         | J               | 16   |             | TBD                     | Call TI          | Call TI                      |
| CD4049UBF3AS2534 | OBSOLETE              | CDIP         | J               | 16   |             | TBD                     | Call TI          | Call TI                      |
| CD4049UBM        | OBSOLETE              | SOIC         | D               | 16   |             | TBD                     | Call TI          | Call TI                      |
| CD4049UBM96      | OBSOLETE              | SOIC         | D               | 16   |             | TBD                     | Call TI          | Call TI                      |
| CD4049UBNSR      | ACTIVE                | SO           | NS              | 16   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD4049UBNSRE4    | ACTIVE                | SO           | NS              | 16   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD4049UBNSRG4    | ACTIVE                | SO           | NS              | 16   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD4049UBPW       | ACTIVE                | TSSOP        | PW              | 16   | 90          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |

| Orderable Device | Status <sup>(1)</sup> | Package Type | Package Drawing | Pins | Package Qty | Eco Plan <sup>(2)</sup> | Lead/Ball Finish | MSL Peak Temp <sup>(3)</sup> |
|------------------|-----------------------|--------------|-----------------|------|-------------|-------------------------|------------------|------------------------------|
| CD4049UBPWE4     | ACTIVE                | TSSOP        | PW              | 16   | 90          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD4049UBPWG4     | ACTIVE                | TSSOP        | PW              | 16   | 90          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD4049UBPWR      | ACTIVE                | TSSOP        | PW              | 16   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD4049UBPWRE4    | ACTIVE                | TSSOP        | PW              | 16   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD4049UBPWG4     | ACTIVE                | TSSOP        | PW              | 16   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD4050BD         | ACTIVE                | SOIC         | D               | 16   | 40          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD4050BDE4       | ACTIVE                | SOIC         | D               | 16   | 40          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD4050BDG4       | ACTIVE                | SOIC         | D               | 16   | 40          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD4050BDR        | ACTIVE                | SOIC         | D               | 16   | 2500        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD4050BDRE4      | ACTIVE                | SOIC         | D               | 16   | 2500        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD4050BDRG4      | ACTIVE                | SOIC         | D               | 16   | 2500        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD4050BDT        | ACTIVE                | SOIC         | D               | 16   | 250         | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD4050BDTE4      | ACTIVE                | SOIC         | D               | 16   | 250         | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD4050BDTG4      | ACTIVE                | SOIC         | D               | 16   | 250         | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD4050BDW        | ACTIVE                | SOIC         | DW              | 16   | 40          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD4050BDWE4      | ACTIVE                | SOIC         | DW              | 16   | 40          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD4050BDWG4      | ACTIVE                | SOIC         | DW              | 16   | 40          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD4050BDWR       | ACTIVE                | SOIC         | DW              | 16   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD4050BDWRE4     | ACTIVE                | SOIC         | DW              | 16   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD4050BDWRG4     | ACTIVE                | SOIC         | DW              | 16   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD4050BE         | ACTIVE                | PDIP         | N               | 16   | 25          | Pb-Free (RoHS)          | CU NIPDAU        | N / A for Pkg Type           |
| CD4050BEE4       | ACTIVE                | PDIP         | N               | 16   | 25          | Pb-Free (RoHS)          | CU NIPDAU        | N / A for Pkg Type           |
| CD4050BF         | ACTIVE                | CDIP         | J               | 16   | 1           | TBD                     | A42              | N / A for Pkg Type           |
| CD4050BF3A       | ACTIVE                | CDIP         | J               | 16   | 1           | TBD                     | A42              | N / A for Pkg Type           |
| CD4050BF3AS2283  | OBSOLETE              | CDIP         | J               | 16   |             | TBD                     | Call TI          | Call TI                      |
| CD4050BF3AS2534  | OBSOLETE              | CDIP         | J               | 16   |             | TBD                     | Call TI          | Call TI                      |
| CD4050BM         | OBSOLETE              | SOIC         | D               | 16   |             | TBD                     | Call TI          | Call TI                      |
| CD4050BNSR       | ACTIVE                | SO           | NS              | 16   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |

| Orderable Device | Status <sup>(1)</sup> | Package Type | Package Drawing | Pins | Package Qty | Eco Plan <sup>(2)</sup> | Lead/Ball Finish | MSL Peak Temp <sup>(3)</sup> |
|------------------|-----------------------|--------------|-----------------|------|-------------|-------------------------|------------------|------------------------------|
| CD4050BNSRE4     | ACTIVE                | SO           | NS              | 16   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD4050BNSRG4     | ACTIVE                | SO           | NS              | 16   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD4050BPW        | ACTIVE                | TSSOP        | PW              | 16   | 90          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD4050BPWE4      | ACTIVE                | TSSOP        | PW              | 16   | 90          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD4050BPWG4      | ACTIVE                | TSSOP        | PW              | 16   | 90          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD4050BPWR       | ACTIVE                | TSSOP        | PW              | 16   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD4050BPWRE4     | ACTIVE                | TSSOP        | PW              | 16   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| CD4050BPWRG4     | ACTIVE                | TSSOP        | PW              | 16   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| JM38510/05553BEA | ACTIVE                | CDIP         | J               | 16   | 1           | TBD                     | A42              | N / A for Pkg Type           |
| JM38510/05554BEA | ACTIVE                | CDIP         | J               | 16   | 1           | TBD                     | A42              | N / A for Pkg Type           |

<sup>(1)</sup> The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

<sup>(2)</sup> Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

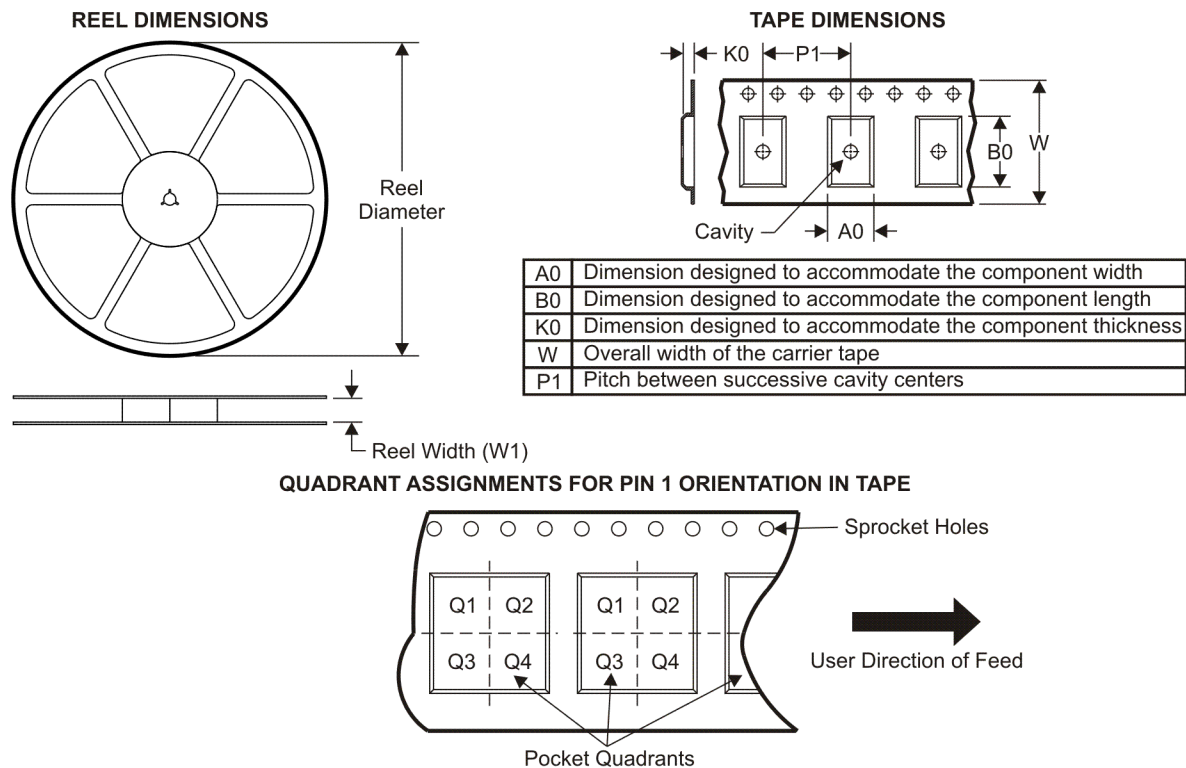
**Green (RoHS & no Sb/Br):** TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

<sup>(3)</sup> MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

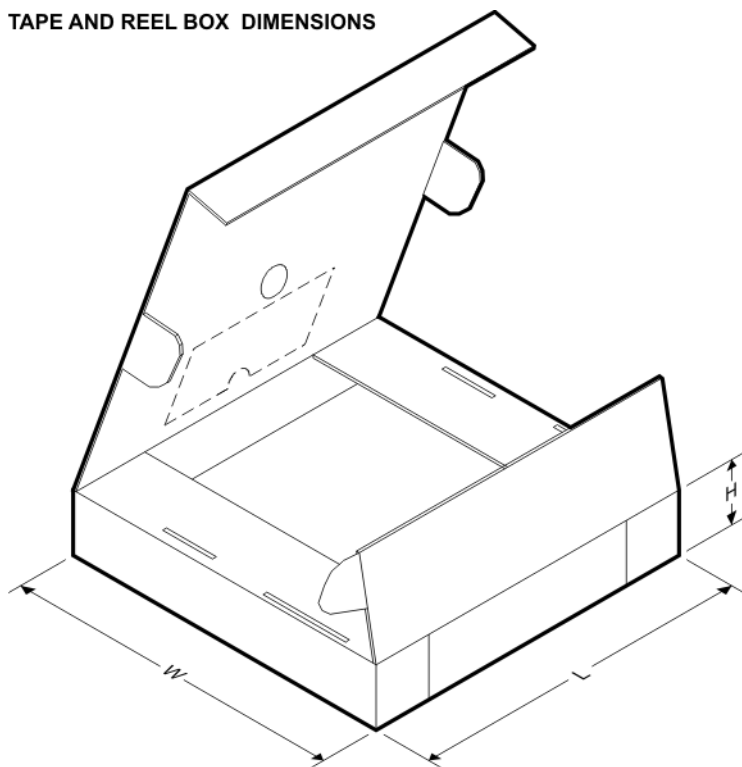
**TAPE AND REEL INFORMATION**



\*All dimensions are nominal

| Device      | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|-------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| CD4049UBDR  | SOIC         | D               | 16   | 2500 | 330.0              | 16.4               | 6.5     | 10.3    | 2.1     | 8.0     | 16.0   | Q1            |
| CD4049UBDWR | SOIC         | DW              | 16   | 2000 | 330.0              | 16.4               | 10.75   | 10.7    | 2.7     | 12.0    | 16.0   | Q1            |
| CD4049UBNSR | SO           | NS              | 16   | 2000 | 330.0              | 16.4               | 8.2     | 10.5    | 2.5     | 12.0    | 16.0   | Q1            |
| CD4049UBPWR | TSSOP        | PW              | 16   | 2000 | 330.0              | 12.4               | 7.0     | 5.6     | 1.6     | 8.0     | 12.0   | Q1            |
| CD4050BDR   | SOIC         | D               | 16   | 2500 | 330.0              | 16.4               | 6.5     | 10.3    | 2.1     | 8.0     | 16.0   | Q1            |
| CD4050BDWR  | SOIC         | DW              | 16   | 2000 | 330.0              | 16.4               | 10.75   | 10.7    | 2.7     | 12.0    | 16.0   | Q1            |
| CD4050BNSR  | SO           | NS              | 16   | 2000 | 330.0              | 16.4               | 8.2     | 10.5    | 2.5     | 12.0    | 16.0   | Q1            |
| CD4050BPWR  | TSSOP        | PW              | 16   | 2000 | 330.0              | 12.4               | 7.0     | 5.6     | 1.6     | 8.0     | 12.0   | Q1            |

**TAPE AND REEL BOX DIMENSIONS**



\*All dimensions are nominal

| Device      | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|-------------|--------------|-----------------|------|------|-------------|------------|-------------|
| CD4049UBDR  | SOIC         | D               | 16   | 2500 | 333.2       | 345.9      | 28.6        |
| CD4049UBDWR | SOIC         | DW              | 16   | 2000 | 346.0       | 346.0      | 33.0        |
| CD4049UBNSR | SO           | NS              | 16   | 2000 | 346.0       | 346.0      | 33.0        |
| CD4049UBPWR | TSSOP        | PW              | 16   | 2000 | 346.0       | 346.0      | 29.0        |
| CD4050BDR   | SOIC         | D               | 16   | 2500 | 333.2       | 345.9      | 28.6        |
| CD4050BDWR  | SOIC         | DW              | 16   | 2000 | 346.0       | 346.0      | 33.0        |
| CD4050BNSR  | SO           | NS              | 16   | 2000 | 346.0       | 346.0      | 33.0        |
| CD4050BPWR  | TSSOP        | PW              | 16   | 2000 | 346.0       | 346.0      | 29.0        |

J (R-GDIP-T\*\*)

14 LEADS SHOWN

# CERAMIC DUAL IN-LINE PACKAGE



| PINS **<br>DIM | 14                     | 16                     | 18                     | 20                     |
|----------------|------------------------|------------------------|------------------------|------------------------|
| A              | 0.300<br>(7,62)<br>BSC | 0.300<br>(7,62)<br>BSC | 0.300<br>(7,62)<br>BSC | 0.300<br>(7,62)<br>BSC |
| B MAX          | 0.785<br>(19,94)       | .840<br>(21,34)        | 0.960<br>(24,38)       | 1.060<br>(26,92)       |
| B MIN          | —                      | —                      | —                      | —                      |
| C MAX          | 0.300<br>(7,62)        | 0.300<br>(7,62)        | 0.310<br>(7,87)        | 0.300<br>(7,62)        |
| C MIN          | 0.245<br>(6,22)        | 0.245<br>(6,22)        | 0.220<br>(5,59)        | 0.245<br>(6,22)        |



4040083/F 03/03

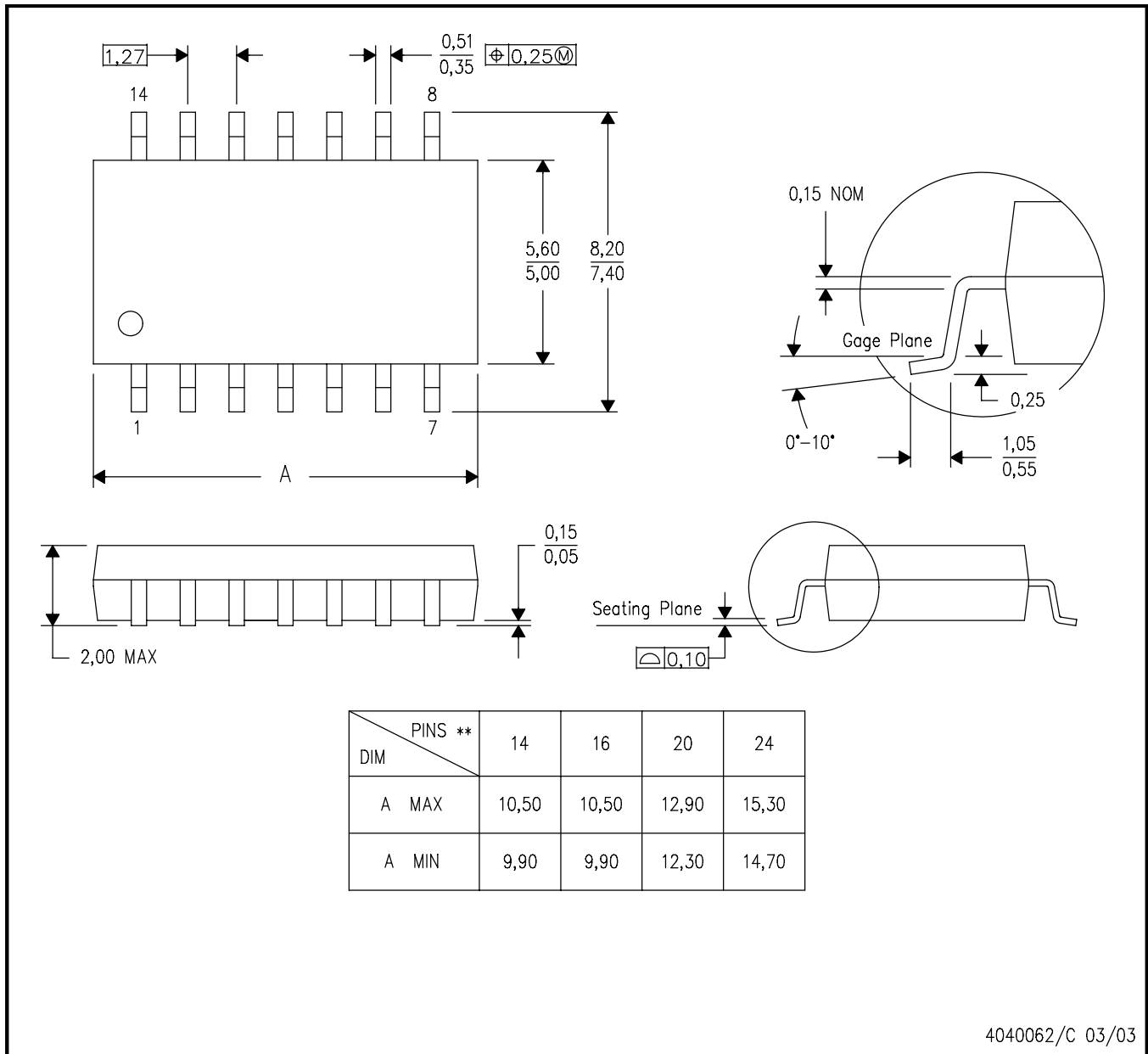
- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - C. This package is hermetically sealed with a ceramic lid using glass frit.
  - D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
  - E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

# MECHANICAL DATA

NS (R-PDSO-G\*\*)

PLASTIC SMALL-OUTLINE PACKAGE

14-PINS SHOWN



- NOTES:
- A. All linear dimensions are in millimeters.
  - B. This drawing is subject to change without notice.
  - C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.

## PW (R-PDSO-G\*\*)

## PLASTIC SMALL-OUTLINE PACKAGE

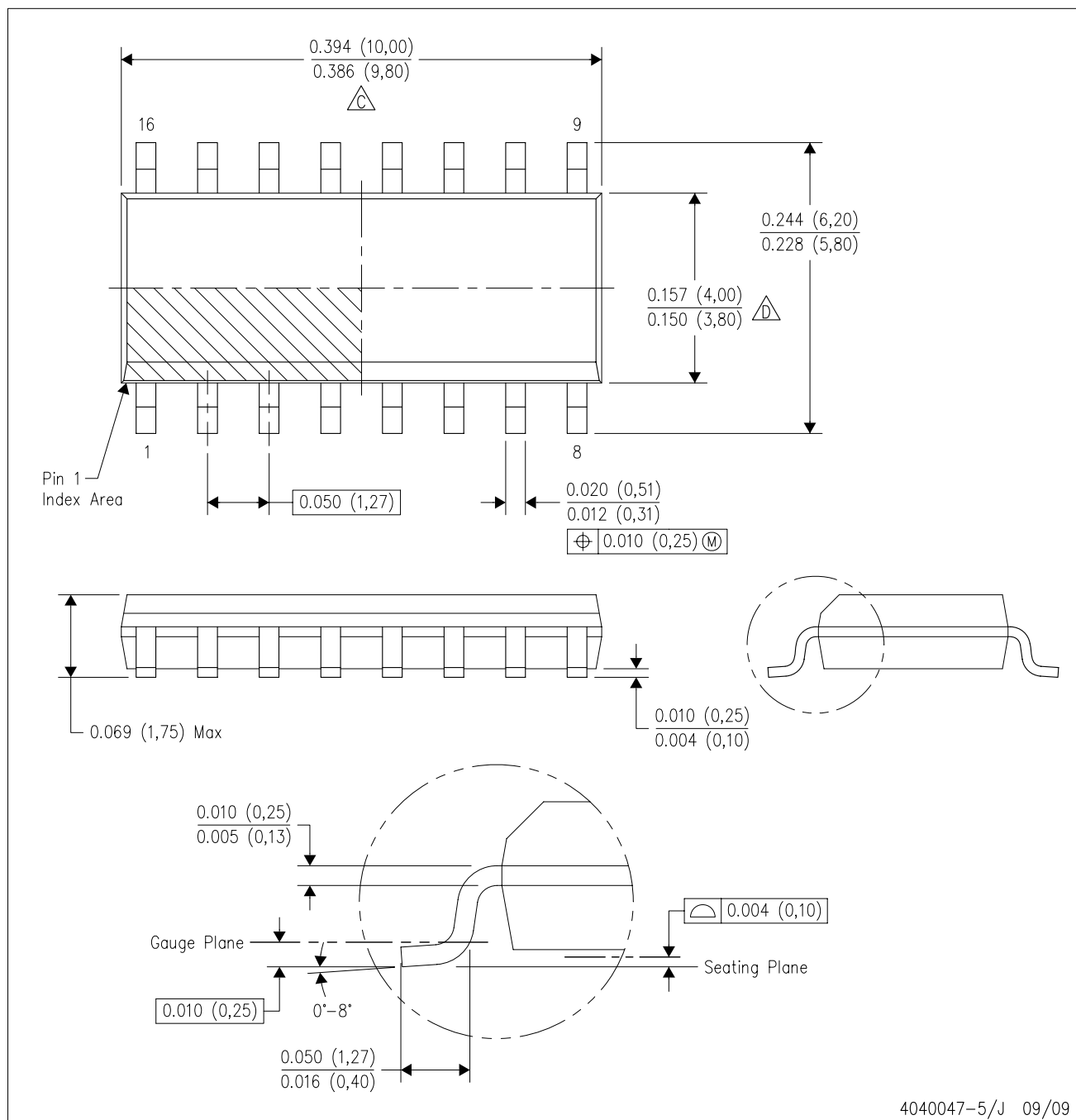
14 PINS SHOWN



- NOTES: A. All linear dimensions are in millimeters.  
 B. This drawing is subject to change without notice.  
 C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.  
 D. Falls within JEDEC MO-153

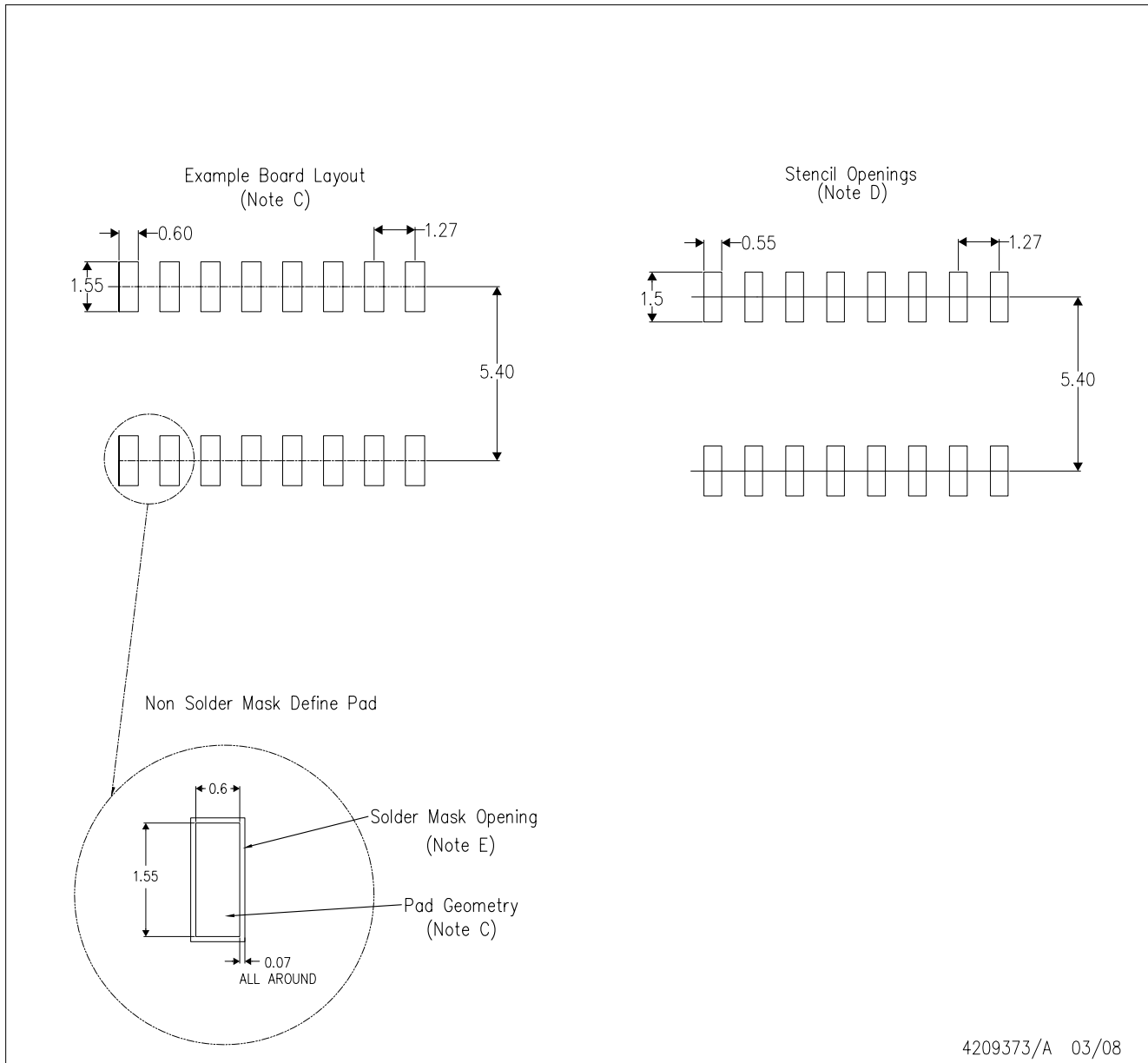
D (R-PDSO-G16)

PLASTIC SMALL-OUTLINE PACKAGE



- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - C. Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed .006 (0,15) per end.
  - D. Body width does not include interlead flash. Interlead flash shall not exceed .017 (0,43) per side.
  - E. Reference JEDEC MS-012 variation AC.

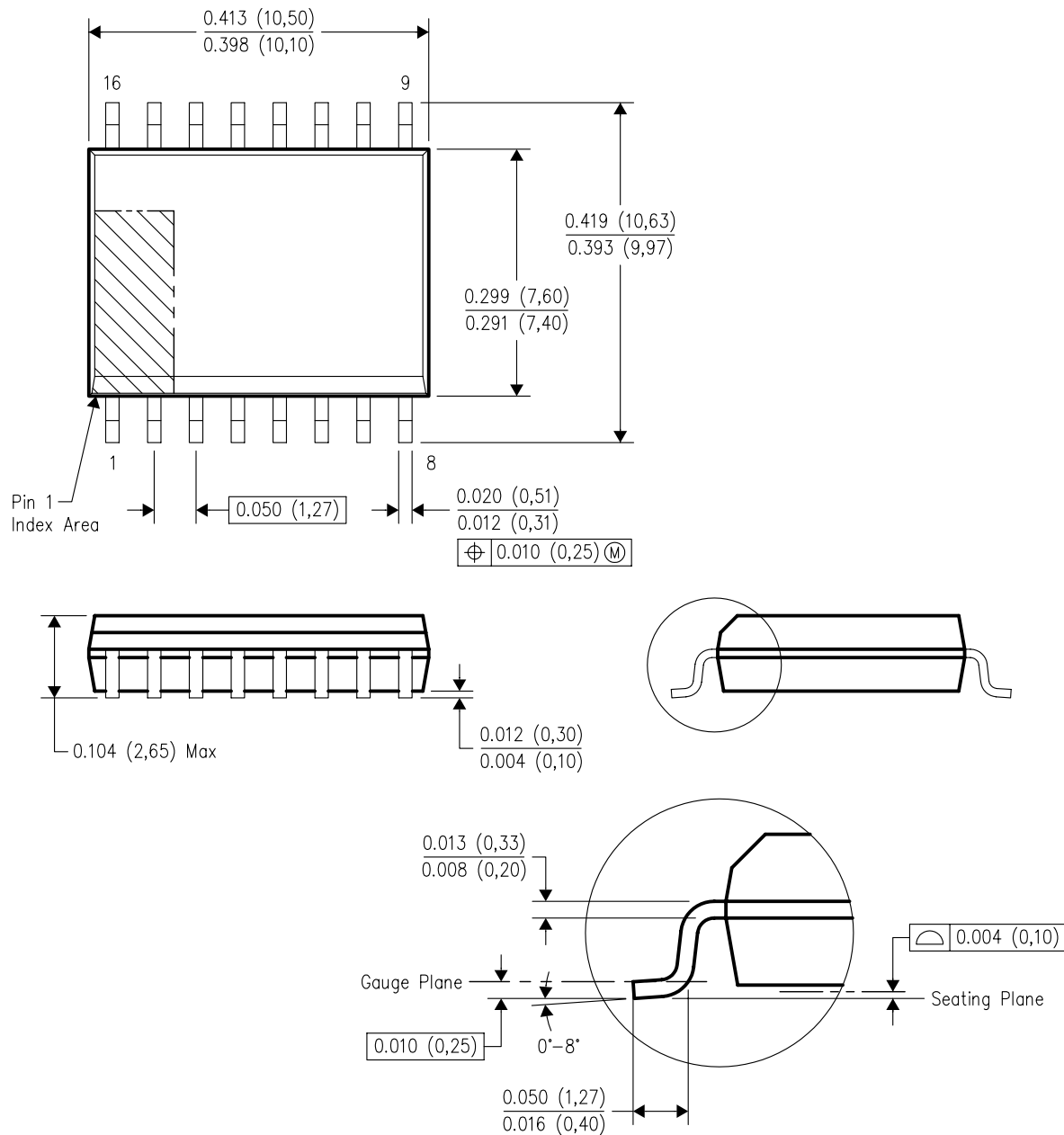
## D(R-PDSO-G16)



- NOTES:
- A. All linear dimensions are in millimeters.
  - B. This drawing is subject to change without notice.
  - C. Refer to IPC7351 for alternate board design.
  - D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525
  - E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.

DW (R-PDSO-G16)

# PLASTIC SMALL-OUTLINE PACKAGE



4040000-2/F 06/2004

- NOTES: A. All linear dimensions are in inches (millimeters).  
B. This drawing is subject to change without notice.  
C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).  
D. Falls within JEDEC MS-013 variation AA.

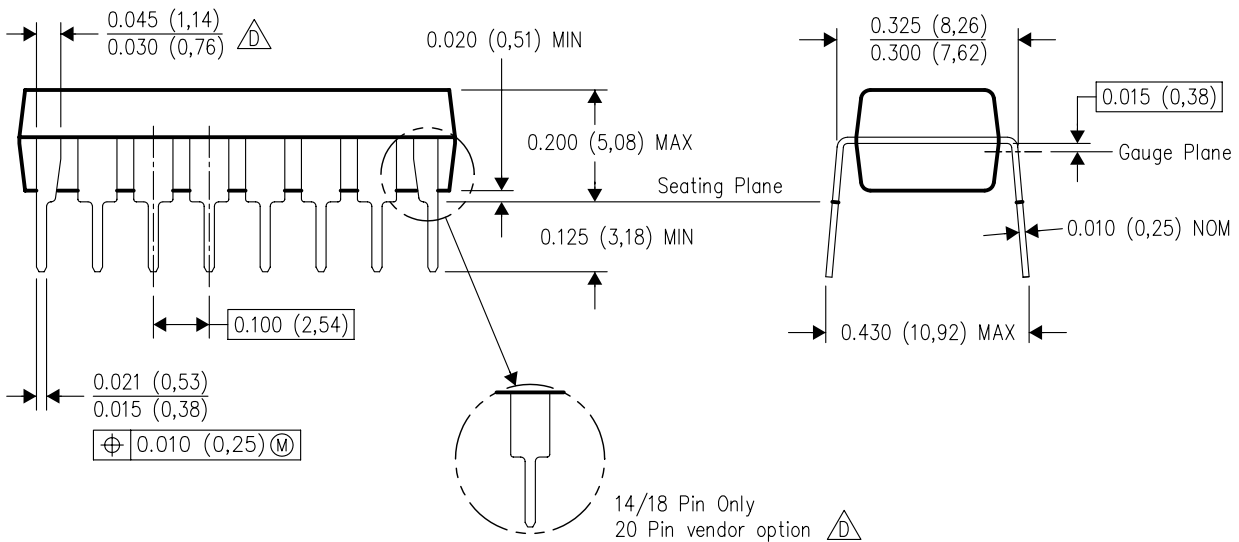
## N (R-PDIP-T\*\*)

16 PINS SHOWN

## PLASTIC DUAL-IN-LINE PACKAGE



| PINS **             | 14               | 16               | 18               | 20               |
|---------------------|------------------|------------------|------------------|------------------|
| DIM                 |                  |                  |                  |                  |
| A MAX               | 0.775<br>(19,69) | 0.775<br>(19,69) | 0.920<br>(23,37) | 1.060<br>(26,92) |
| A MIN               | 0.745<br>(18,92) | 0.745<br>(18,92) | 0.850<br>(21,59) | 0.940<br>(23,88) |
| MS-001<br>VARIATION | AA               | BB               | AC               | AD               |



4040049/E 12/2002

- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - C. Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
  - D. The 20 pin end lead shoulder width is a vendor option, either half or full width.

**PACKAGING INFORMATION**

| Orderable Device | Status<br>(1) | Package Type | Package<br>Drawing | Pins | Package Qty | Eco Plan<br>(2)            | Lead/Ball Finish | MSL Peak Temp<br>(3) | Op Temp (°C) | Top-Side Markings<br>(4) | Samples                 |
|------------------|---------------|--------------|--------------------|------|-------------|----------------------------|------------------|----------------------|--------------|--------------------------|-------------------------|
| CD4049UBD        | ACTIVE        | SOIC         | D                  | 16   | 40          | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM   | -55 to 125   | CD4049UBM                | <a href="#">Samples</a> |
| CD4049UBDE4      | ACTIVE        | SOIC         | D                  | 16   | 40          | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM   | -55 to 125   | CD4049UBM                | <a href="#">Samples</a> |
| CD4049UBDG4      | ACTIVE        | SOIC         | D                  | 16   | 40          | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM   | -55 to 125   | CD4049UBM                | <a href="#">Samples</a> |
| CD4049UBDR       | ACTIVE        | SOIC         | D                  | 16   | 2500        | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM   | -55 to 125   | CD4049UBM                | <a href="#">Samples</a> |
| CD4049UBDRE4     | ACTIVE        | SOIC         | D                  | 16   | 2500        | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM   | -55 to 125   | CD4049UBM                | <a href="#">Samples</a> |
| CD4049UBDRG4     | ACTIVE        | SOIC         | D                  | 16   | 2500        | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM   | -55 to 125   | CD4049UBM                | <a href="#">Samples</a> |
| CD4049UBDT       | ACTIVE        | SOIC         | D                  | 16   | 250         | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM   | -55 to 125   | CD4049UBM                | <a href="#">Samples</a> |
| CD4049UBDTE4     | ACTIVE        | SOIC         | D                  | 16   | 250         | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM   | -55 to 125   | CD4049UBM                | <a href="#">Samples</a> |
| CD4049UBDTG4     | ACTIVE        | SOIC         | D                  | 16   | 250         | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM   | -55 to 125   | CD4049UBM                | <a href="#">Samples</a> |
| CD4049UBDW       | ACTIVE        | SOIC         | DW                 | 16   | 40          | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM   | -55 to 125   | CD4049UBM                | <a href="#">Samples</a> |
| CD4049UBDWE4     | ACTIVE        | SOIC         | DW                 | 16   | 40          | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM   | -55 to 125   | CD4049UBM                | <a href="#">Samples</a> |
| CD4049UBDWG4     | ACTIVE        | SOIC         | DW                 | 16   | 40          | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM   | -55 to 125   | CD4049UBM                | <a href="#">Samples</a> |
| CD4049UBDWR      | ACTIVE        | SOIC         | DW                 | 16   | 2000        | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM   | -55 to 125   | CD4049UBM                | <a href="#">Samples</a> |
| CD4049UBDWRE4    | ACTIVE        | SOIC         | DW                 | 16   | 2000        | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM   | -55 to 125   | CD4049UBM                | <a href="#">Samples</a> |
| CD4049UBDWRG4    | ACTIVE        | SOIC         | DW                 | 16   | 2000        | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM   | -55 to 125   | CD4049UBM                | <a href="#">Samples</a> |
| CD4049UBE        | ACTIVE        | PDIP         | N                  | 16   | 25          | Pb-Free<br>(RoHS)          | CU NIPDAU        | N / A for Pkg Type   | -55 to 125   | CD4049UBE                | <a href="#">Samples</a> |
| CD4049UBEE4      | ACTIVE        | PDIP         | N                  | 16   | 25          | Pb-Free<br>(RoHS)          | CU NIPDAU        | N / A for Pkg Type   | -55 to 125   | CD4049UBE                | <a href="#">Samples</a> |

| Orderable Device | Status<br>(1) | Package Type | Package<br>Drawing | Pins | Package Qty | Eco Plan<br>(2)            | Lead/Ball Finish | MSL Peak Temp<br>(3) | Op Temp (°C) | Top-Side Markings<br>(4) | Samples                 |
|------------------|---------------|--------------|--------------------|------|-------------|----------------------------|------------------|----------------------|--------------|--------------------------|-------------------------|
| CD4049UBF        | ACTIVE        | CDIP         | J                  | 16   | 1           | TBD                        | A42              | N / A for Pkg Type   | -55 to 125   | CD4049UBF                | <a href="#">Samples</a> |
| CD4049UBF3A      | ACTIVE        | CDIP         | J                  | 16   | 1           | TBD                        | A42              | N / A for Pkg Type   | -55 to 125   | CD4049UBF3A              | <a href="#">Samples</a> |
| CD4049UBF3AS2283 | OBSOLETE      | CDIP         | J                  | 16   |             | TBD                        | Call TI          | Call TI              |              |                          |                         |
| CD4049UBF3AS2534 | OBSOLETE      | CDIP         | J                  | 16   |             | TBD                        | Call TI          | Call TI              |              |                          |                         |
| CD4049UBM        | OBSOLETE      | SOIC         | D                  | 16   |             | TBD                        | Call TI          | Call TI              | -55 to 125   |                          |                         |
| CD4049UBM96      | OBSOLETE      | SOIC         | D                  | 16   |             | TBD                        | Call TI          | Call TI              | -55 to 125   |                          |                         |
| CD4049UBNSR      | ACTIVE        | SO           | NS                 | 16   | 2000        | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM   | -55 to 125   | CD4049UB                 | <a href="#">Samples</a> |
| CD4049UBNSRE4    | ACTIVE        | SO           | NS                 | 16   | 2000        | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM   | -55 to 125   | CD4049UB                 | <a href="#">Samples</a> |
| CD4049UBNSRG4    | ACTIVE        | SO           | NS                 | 16   | 2000        | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM   | -55 to 125   | CD4049UB                 | <a href="#">Samples</a> |
| CD4049UBPW       | ACTIVE        | TSSOP        | PW                 | 16   | 90          | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM   | -55 to 125   | CM049UB                  | <a href="#">Samples</a> |
| CD4049UBPWE4     | ACTIVE        | TSSOP        | PW                 | 16   | 90          | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM   | -55 to 125   | CM049UB                  | <a href="#">Samples</a> |
| CD4049UBPWG4     | ACTIVE        | TSSOP        | PW                 | 16   | 90          | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM   | -55 to 125   | CM049UB                  | <a href="#">Samples</a> |
| CD4049UBPWR      | ACTIVE        | TSSOP        | PW                 | 16   | 2000        | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM   | -55 to 125   | CM049UB                  | <a href="#">Samples</a> |
| CD4049UBPWRE4    | ACTIVE        | TSSOP        | PW                 | 16   | 2000        | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM   | -55 to 125   | CM049UB                  | <a href="#">Samples</a> |
| CD4049UBPWG4     | ACTIVE        | TSSOP        | PW                 | 16   | 2000        | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM   | -55 to 125   | CM049UB                  | <a href="#">Samples</a> |
| CD4050BD         | ACTIVE        | SOIC         | D                  | 16   | 40          | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM   | -55 to 125   | CD4050BM                 | <a href="#">Samples</a> |
| CD4050BDE4       | ACTIVE        | SOIC         | D                  | 16   | 40          | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM   | -55 to 125   | CD4050BM                 | <a href="#">Samples</a> |
| CD4050BDG4       | ACTIVE        | SOIC         | D                  | 16   | 40          | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM   | -55 to 125   | CD4050BM                 | <a href="#">Samples</a> |
| CD4050BDR        | ACTIVE        | SOIC         | D                  | 16   | 2500        | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM   | -55 to 125   | CD4050BM                 | <a href="#">Samples</a> |
| CD4050BDRE4      | ACTIVE        | SOIC         | D                  | 16   | 2500        | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM   | -55 to 125   | CD4050BM                 | <a href="#">Samples</a> |

| Orderable Device | Status<br>(1) | Package Type | Package<br>Drawing | Pins | Package Qty | Eco Plan<br>(2)            | Lead/Ball Finish | MSL Peak Temp<br>(3) | Op Temp (°C) | Top-Side Markings<br>(4) | Samples                 |
|------------------|---------------|--------------|--------------------|------|-------------|----------------------------|------------------|----------------------|--------------|--------------------------|-------------------------|
| CD4050BDRG4      | ACTIVE        | SOIC         | D                  | 16   | 2500        | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM   | -55 to 125   | CD4050BM                 | <a href="#">Samples</a> |
| CD4050BDT        | ACTIVE        | SOIC         | D                  | 16   | 250         | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM   | -55 to 125   | CD4050BM                 | <a href="#">Samples</a> |
| CD4050BDTE4      | ACTIVE        | SOIC         | D                  | 16   | 250         | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM   | -55 to 125   | CD4050BM                 | <a href="#">Samples</a> |
| CD4050BDTG4      | ACTIVE        | SOIC         | D                  | 16   | 250         | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM   | -55 to 125   | CD4050BM                 | <a href="#">Samples</a> |
| CD4050BDW        | ACTIVE        | SOIC         | DW                 | 16   | 40          | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM   | -55 to 125   | CD4050BM                 | <a href="#">Samples</a> |
| CD4050BDWE4      | ACTIVE        | SOIC         | DW                 | 16   | 40          | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM   | -55 to 125   | CD4050BM                 | <a href="#">Samples</a> |
| CD4050BDWG4      | ACTIVE        | SOIC         | DW                 | 16   | 40          | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM   | -55 to 125   | CD4050BM                 | <a href="#">Samples</a> |
| CD4050BDWR       | ACTIVE        | SOIC         | DW                 | 16   | 2000        | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM   | -55 to 125   | CD4050BM                 | <a href="#">Samples</a> |
| CD4050BDWRE4     | ACTIVE        | SOIC         | DW                 | 16   | 2000        | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM   | -55 to 125   | CD4050BM                 | <a href="#">Samples</a> |
| CD4050BDWRG4     | ACTIVE        | SOIC         | DW                 | 16   | 2000        | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM   | -55 to 125   | CD4050BM                 | <a href="#">Samples</a> |
| CD4050BE         | ACTIVE        | PDIP         | N                  | 16   | 25          | Pb-Free<br>(RoHS)          | CU NIPDAU        | N / A for Pkg Type   | -55 to 125   | CD4050BE                 | <a href="#">Samples</a> |
| CD4050BEE4       | ACTIVE        | PDIP         | N                  | 16   | 25          | Pb-Free<br>(RoHS)          | CU NIPDAU        | N / A for Pkg Type   | -55 to 125   | CD4050BE                 | <a href="#">Samples</a> |
| CD4050BF         | ACTIVE        | CDIP         | J                  | 16   | 1           | TBD                        | A42              | N / A for Pkg Type   | -55 to 125   | CD4050BF                 | <a href="#">Samples</a> |
| CD4050BF3A       | ACTIVE        | CDIP         | J                  | 16   | 1           | TBD                        | A42              | N / A for Pkg Type   | -55 to 125   | CD4050BF3A               | <a href="#">Samples</a> |
| CD4050BF3AS2283  | OBSOLETE      | CDIP         | J                  | 16   |             | TBD                        | Call TI          | Call TI              |              |                          |                         |
| CD4050BF3AS2534  | OBSOLETE      | CDIP         | J                  | 16   |             | TBD                        | Call TI          | Call TI              |              |                          |                         |
| CD4050BM         | OBSOLETE      | SOIC         | D                  | 16   |             | TBD                        | Call TI          | Call TI              | -55 to 125   |                          |                         |
| CD4050BNSR       | ACTIVE        | SO           | NS                 | 16   | 2000        | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM   | -55 to 125   | CD4050B                  | <a href="#">Samples</a> |
| CD4050BNSRE4     | ACTIVE        | SO           | NS                 | 16   | 2000        | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM   | -55 to 125   | CD4050B                  | <a href="#">Samples</a> |

| Orderable Device | Status<br>(1) | Package Type | Package<br>Drawing | Pins | Package Qty | Eco Plan<br>(2)            | Lead/Ball Finish | MSL Peak Temp<br>(3) | Op Temp (°C) | Top-Side Markings<br>(4) | Samples                 |
|------------------|---------------|--------------|--------------------|------|-------------|----------------------------|------------------|----------------------|--------------|--------------------------|-------------------------|
| CD4050BNSRG4     | ACTIVE        | SO           | NS                 | 16   | 2000        | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM   | -55 to 125   | CD4050B                  | <a href="#">Samples</a> |
| CD4050BPW        | ACTIVE        | TSSOP        | PW                 | 16   | 90          | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM   | -55 to 125   | CM050B                   | <a href="#">Samples</a> |
| CD4050BPWE4      | ACTIVE        | TSSOP        | PW                 | 16   | 90          | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM   | -55 to 125   | CM050B                   | <a href="#">Samples</a> |
| CD4050BPWG4      | ACTIVE        | TSSOP        | PW                 | 16   | 90          | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM   | -55 to 125   | CM050B                   | <a href="#">Samples</a> |
| CD4050BPWR       | ACTIVE        | TSSOP        | PW                 | 16   | 2000        | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM   | -55 to 125   | CM050B                   | <a href="#">Samples</a> |
| CD4050BPWRE4     | ACTIVE        | TSSOP        | PW                 | 16   | 2000        | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM   | -55 to 125   | CM050B                   | <a href="#">Samples</a> |
| CD4050BPWRG4     | ACTIVE        | TSSOP        | PW                 | 16   | 2000        | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM   | -55 to 125   | CM050B                   | <a href="#">Samples</a> |
| JM38510/05553BEA | ACTIVE        | CDIP         | J                  | 16   | 1           | TBD                        | A42              | N / A for Pkg Type   | -55 to 125   | JM38510/<br>05553BEA     | <a href="#">Samples</a> |
| JM38510/05554BEA | ACTIVE        | CDIP         | J                  | 16   | 1           | TBD                        | A42              | N / A for Pkg Type   | -55 to 125   | JM38510/<br>05554BEA     | <a href="#">Samples</a> |
| M38510/05553BEA  | ACTIVE        | CDIP         | J                  | 16   | 1           | TBD                        | A42              | N / A for Pkg Type   | -55 to 125   | JM38510/<br>05553BEA     | <a href="#">Samples</a> |
| M38510/05554BEA  | ACTIVE        | CDIP         | J                  | 16   | 1           | TBD                        | A42              | N / A for Pkg Type   | -55 to 125   | JM38510/<br>05554BEA     | <a href="#">Samples</a> |

(1) The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

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**Green (RoHS & no Sb/Br):** TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

<sup>(3)</sup> MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

<sup>(4)</sup> Only one of markings shown within the brackets will appear on the physical device.

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In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

**OTHER QUALIFIED VERSIONS OF CD4049UB, CD4049UB-MIL, CD4050B, CD4050B-MIL :**

- Catalog: [CD4049UB](#), [CD4050B](#)
- Military: [CD4049UB-MIL](#), [CD4050B-MIL](#)

NOTE: Qualified Version Definitions:

- Catalog - TI's standard catalog product
- Military - QML certified for Military and Defense Applications

**TAPE AND REEL INFORMATION**


\*All dimensions are nominal

| Device      | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|-------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| CD4049UBDR  | SOIC         | D               | 16   | 2500 | 330.0              | 16.4               | 6.5     | 10.3    | 2.1     | 8.0     | 16.0   | Q1            |
| CD4049UBDWR | SOIC         | DW              | 16   | 2000 | 330.0              | 16.4               | 10.75   | 10.7    | 2.7     | 12.0    | 16.0   | Q1            |
| CD4049UBPWR | TSSOP        | PW              | 16   | 2000 | 330.0              | 12.4               | 6.9     | 5.6     | 1.6     | 8.0     | 12.0   | Q1            |
| CD4050BDR   | SOIC         | D               | 16   | 2500 | 330.0              | 16.4               | 6.5     | 10.3    | 2.1     | 8.0     | 16.0   | Q1            |
| CD4050BDWR  | SOIC         | DW              | 16   | 2000 | 330.0              | 16.4               | 10.75   | 10.7    | 2.7     | 12.0    | 16.0   | Q1            |
| CD4050BPWR  | TSSOP        | PW              | 16   | 2000 | 330.0              | 12.4               | 6.9     | 5.6     | 1.6     | 8.0     | 12.0   | Q1            |

## TAPE AND REEL BOX DIMENSIONS



\*All dimensions are nominal

| Device      | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|-------------|--------------|-----------------|------|------|-------------|------------|-------------|
| CD4049UBDR  | SOIC         | D               | 16   | 2500 | 333.2       | 345.9      | 28.6        |
| CD4049UBDWR | SOIC         | DW              | 16   | 2000 | 367.0       | 367.0      | 38.0        |
| CD4049UBPWR | TSSOP        | PW              | 16   | 2000 | 367.0       | 367.0      | 35.0        |
| CD4050BDR   | SOIC         | D               | 16   | 2500 | 333.2       | 345.9      | 28.6        |
| CD4050BDWR  | SOIC         | DW              | 16   | 2000 | 367.0       | 367.0      | 38.0        |
| CD4050BPWR  | TSSOP        | PW              | 16   | 2000 | 367.0       | 367.0      | 35.0        |

J (R-GDIP-T\*\*)

14 LEADS SHOWN

# CERAMIC DUAL IN-LINE PACKAGE



| PINS **<br>DIM | 14                     | 16                     | 18                     | 20                     |
|----------------|------------------------|------------------------|------------------------|------------------------|
| A              | 0.300<br>(7,62)<br>BSC | 0.300<br>(7,62)<br>BSC | 0.300<br>(7,62)<br>BSC | 0.300<br>(7,62)<br>BSC |
| B MAX          | 0.785<br>(19,94)       | .840<br>(21,34)        | 0.960<br>(24,38)       | 1.060<br>(26,92)       |
| B MIN          | —                      | —                      | —                      | —                      |
| C MAX          | 0.300<br>(7,62)        | 0.300<br>(7,62)        | 0.310<br>(7,87)        | 0.300<br>(7,62)        |
| C MIN          | 0.245<br>(6,22)        | 0.245<br>(6,22)        | 0.220<br>(5,59)        | 0.245<br>(6,22)        |



4040083/F 03/03

- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - C. This package is hermetically sealed with a ceramic lid using glass frit.
  - D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
  - E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

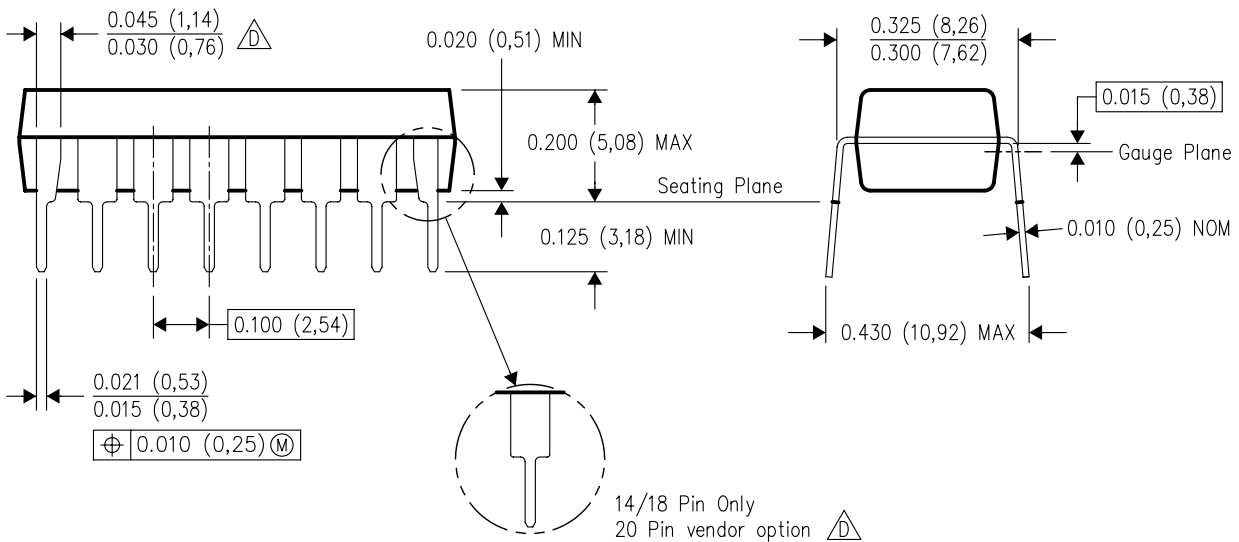
## N (R-PDIP-T\*\*)

16 PINS SHOWN

## PLASTIC DUAL-IN-LINE PACKAGE



| PINS **             | 14               | 16               | 18               | 20               |
|---------------------|------------------|------------------|------------------|------------------|
| DIM                 |                  |                  |                  |                  |
| A MAX               | 0.775<br>(19,69) | 0.775<br>(19,69) | 0.920<br>(23,37) | 1.060<br>(26,92) |
| A MIN               | 0.745<br>(18,92) | 0.745<br>(18,92) | 0.850<br>(21,59) | 0.940<br>(23,88) |
| MS-001<br>VARIATION | AA               | BB               | AC               | AD               |

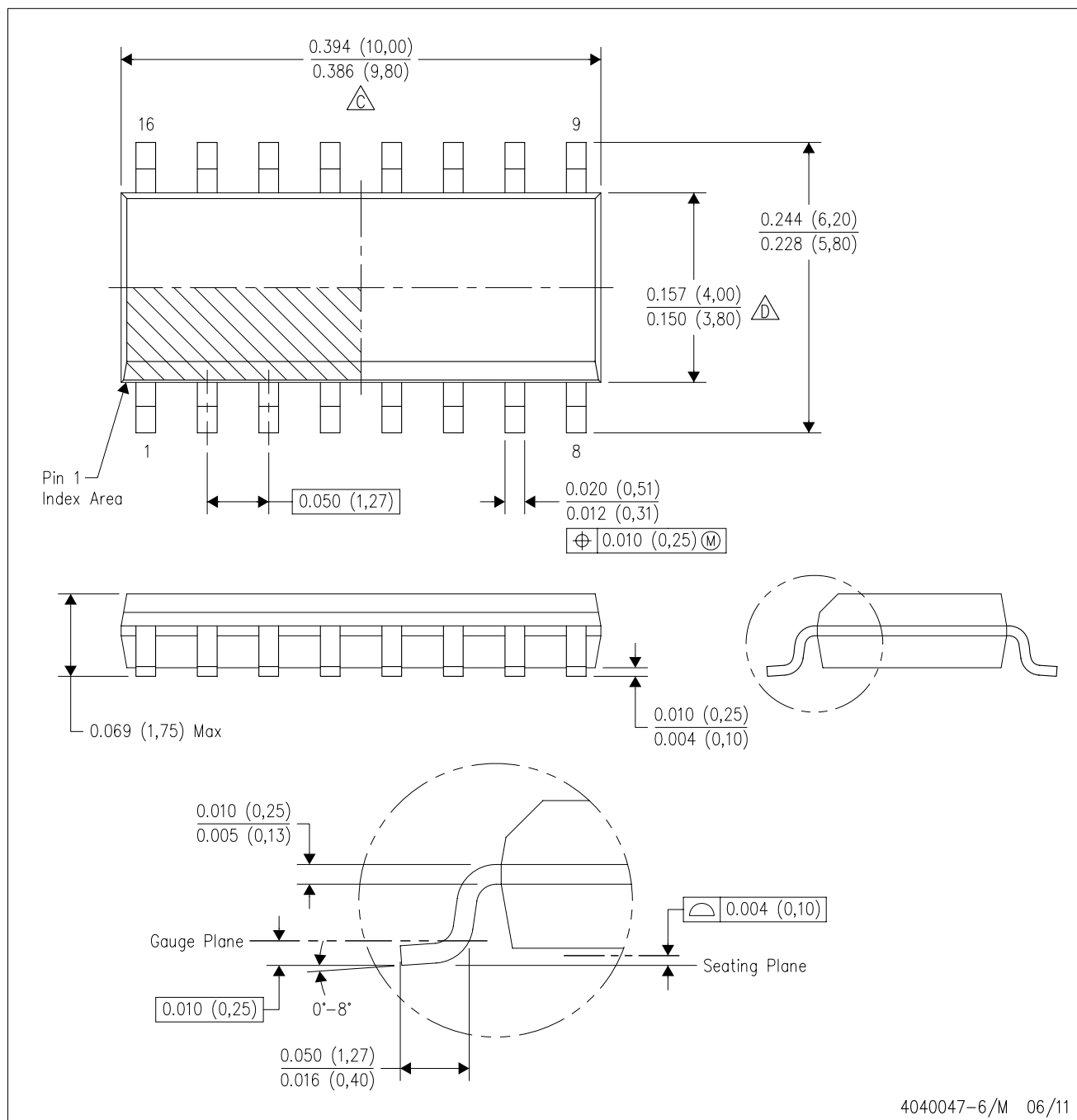


4040049/E 12/2002

- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - C. Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
  - D. The 20 pin end lead shoulder width is a vendor option, either half or full width.

D (R-PDSO-G16)

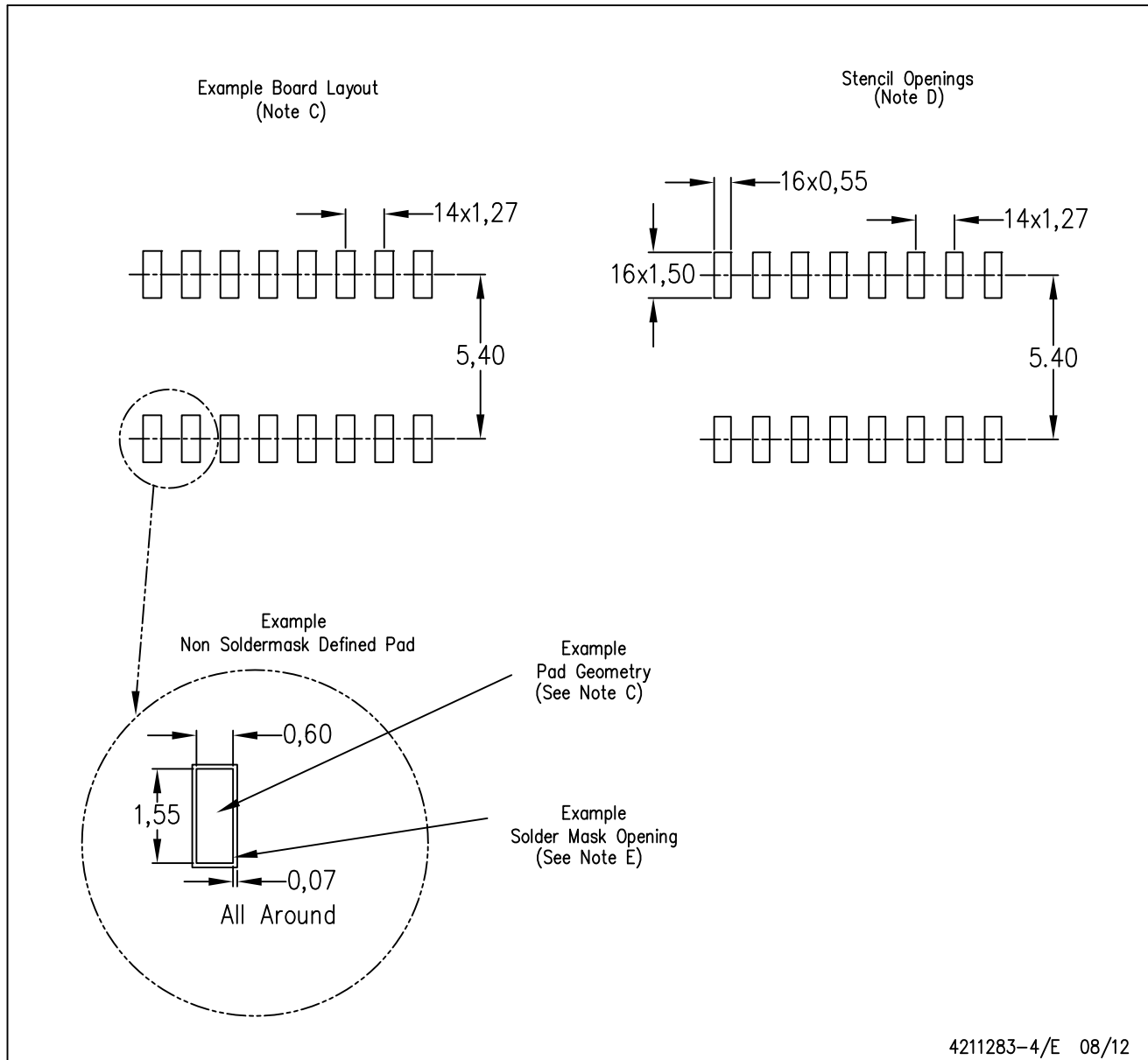
PLASTIC SMALL OUTLINE



- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - $\triangle C$  Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
  - $\triangle D$  Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
  - E. Reference JEDEC MS-012 variation AC.

D (R-PDSO-G16)

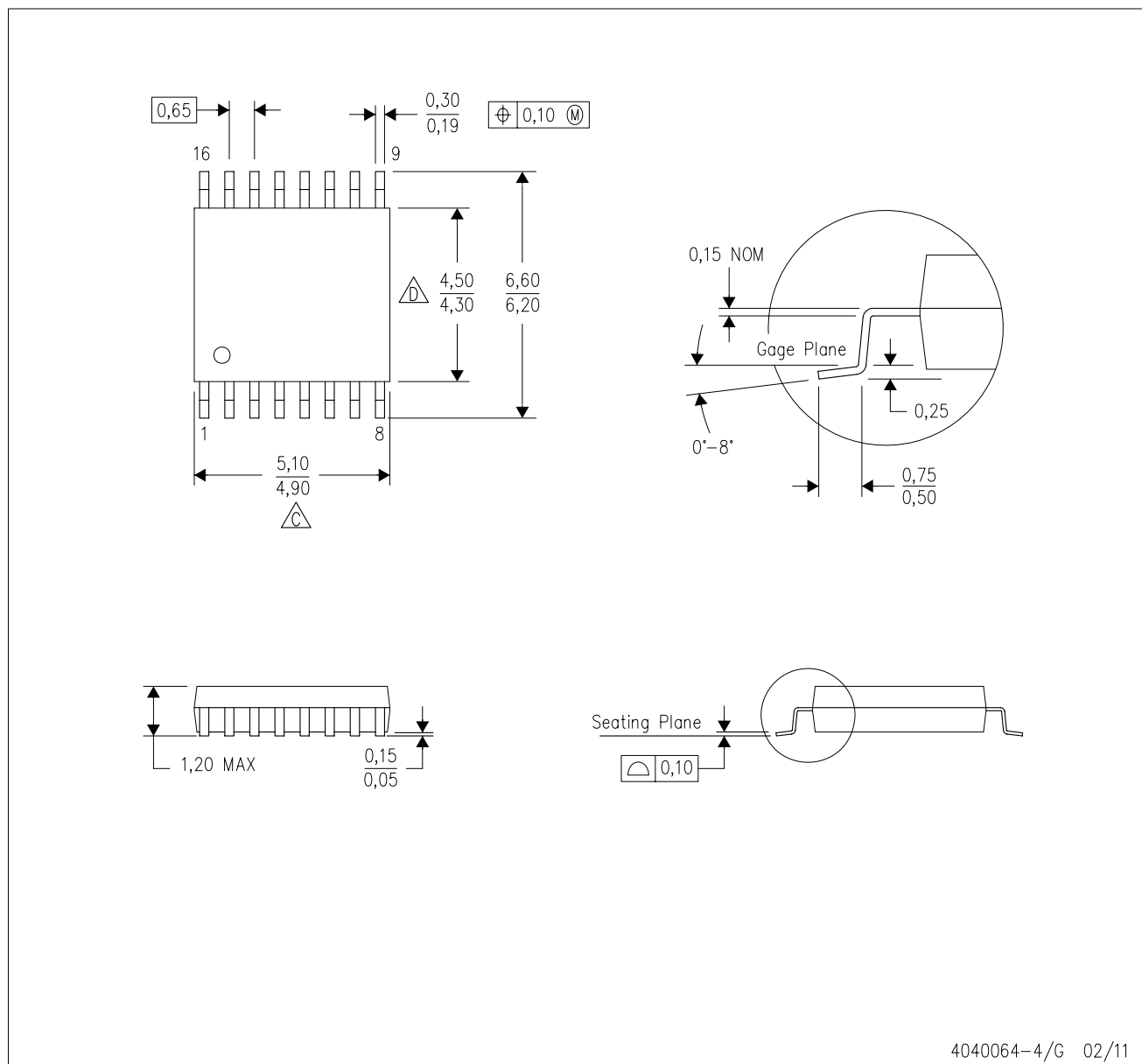
PLASTIC SMALL OUTLINE



- NOTES:
- A. All linear dimensions are in millimeters.
  - B. This drawing is subject to change without notice.
  - C. Publication IPC-7351 is recommended for alternate designs.
  - D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
  - E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.

PW (R-PDSO-G16)

PLASTIC SMALL OUTLINE

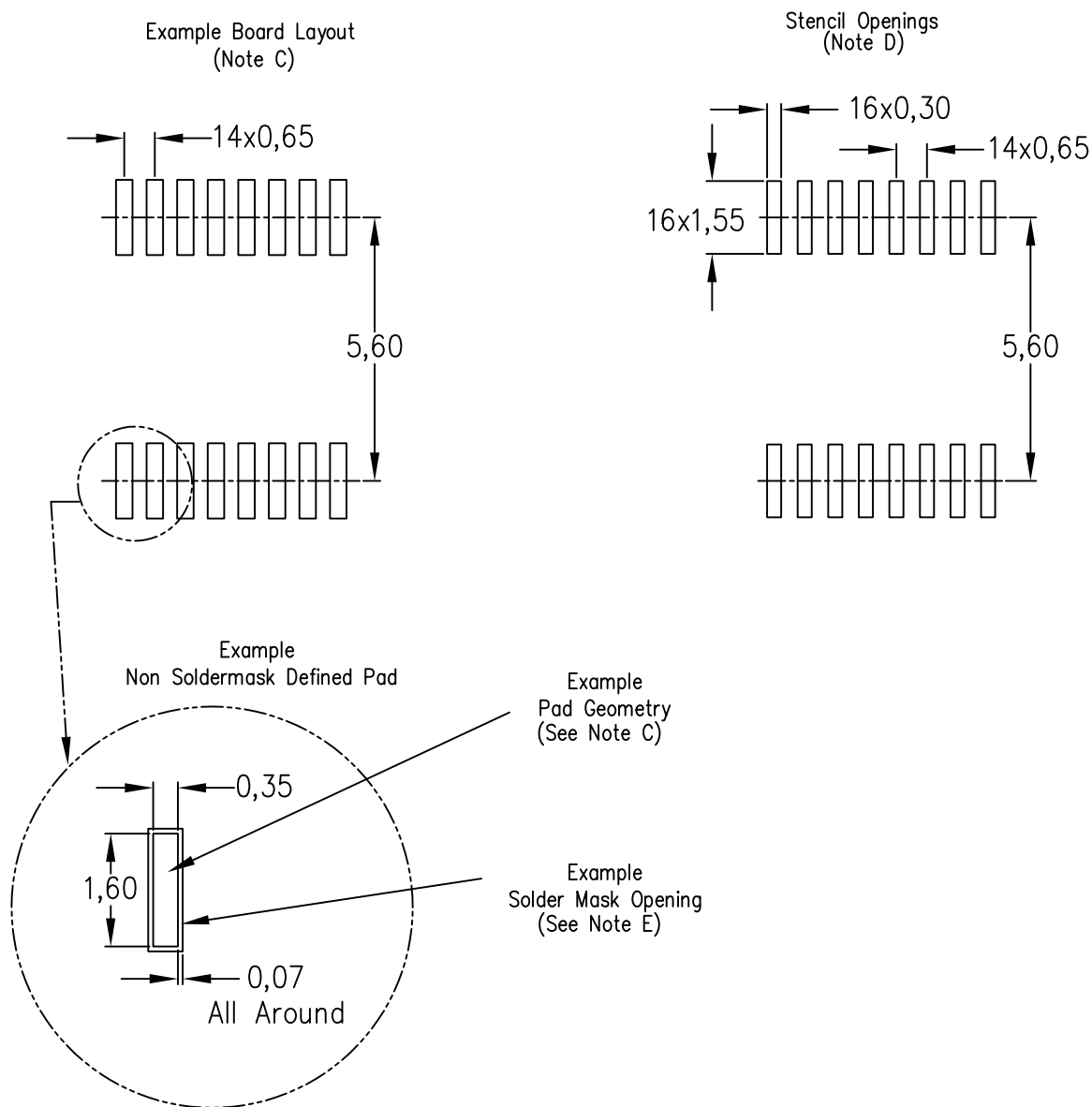


4040064-4/G 02/11

- NOTES:
- A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.
  - B. This drawing is subject to change without notice.
  - C. Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0,15 each side.
  - D. Body width does not include interlead flash. Interlead flash shall not exceed 0,25 each side.
  - E. Falls within JEDEC MO-153

PW (R-PDSO-G16)

PLASTIC SMALL OUTLINE

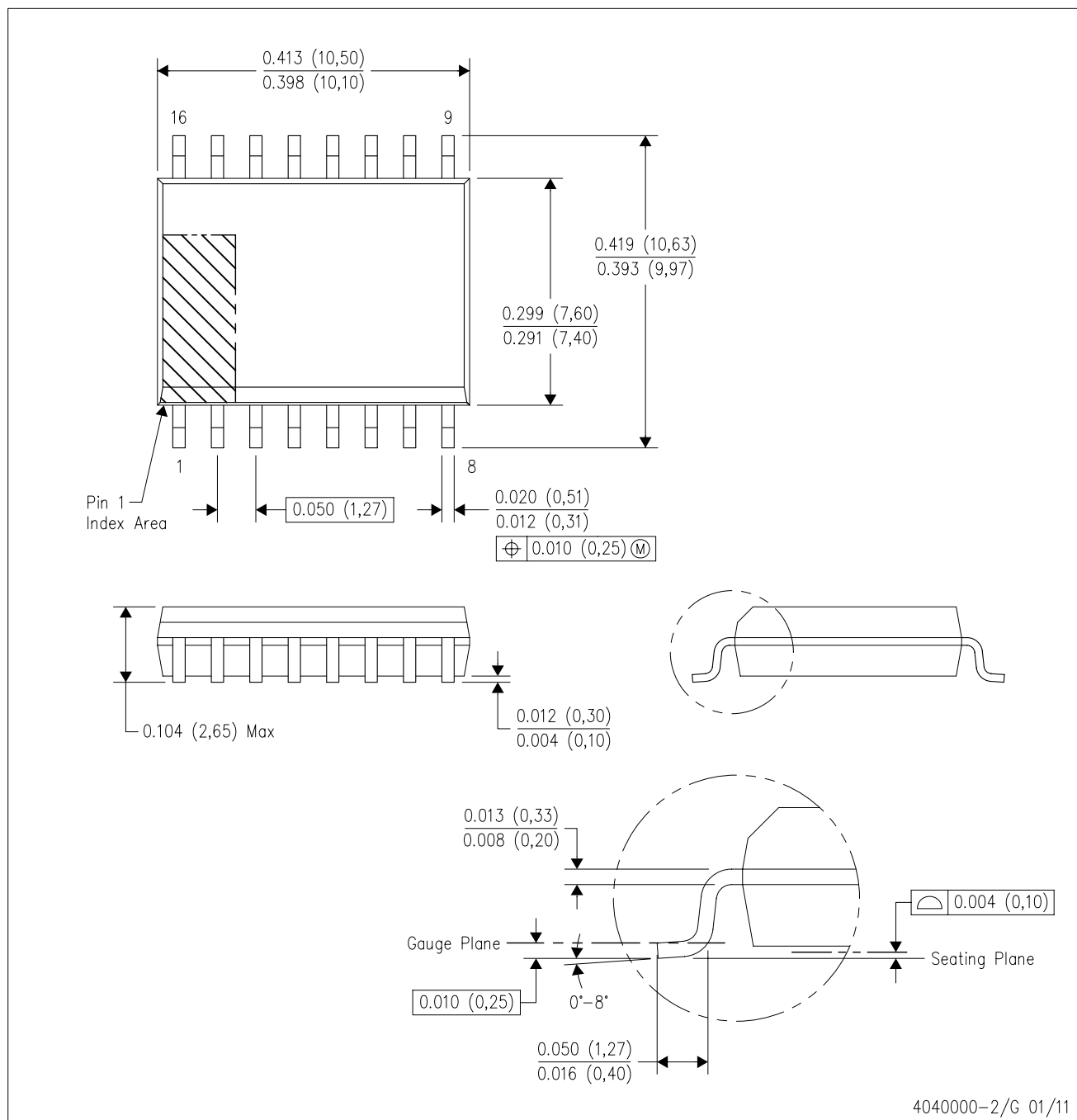


4211284-3/F 12/12

- NOTES:
- A. All linear dimensions are in millimeters.
  - B. This drawing is subject to change without notice.
  - C. Publication IPC-7351 is recommended for alternate designs.
  - D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
  - E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.

DW (R-PDSO-G16)

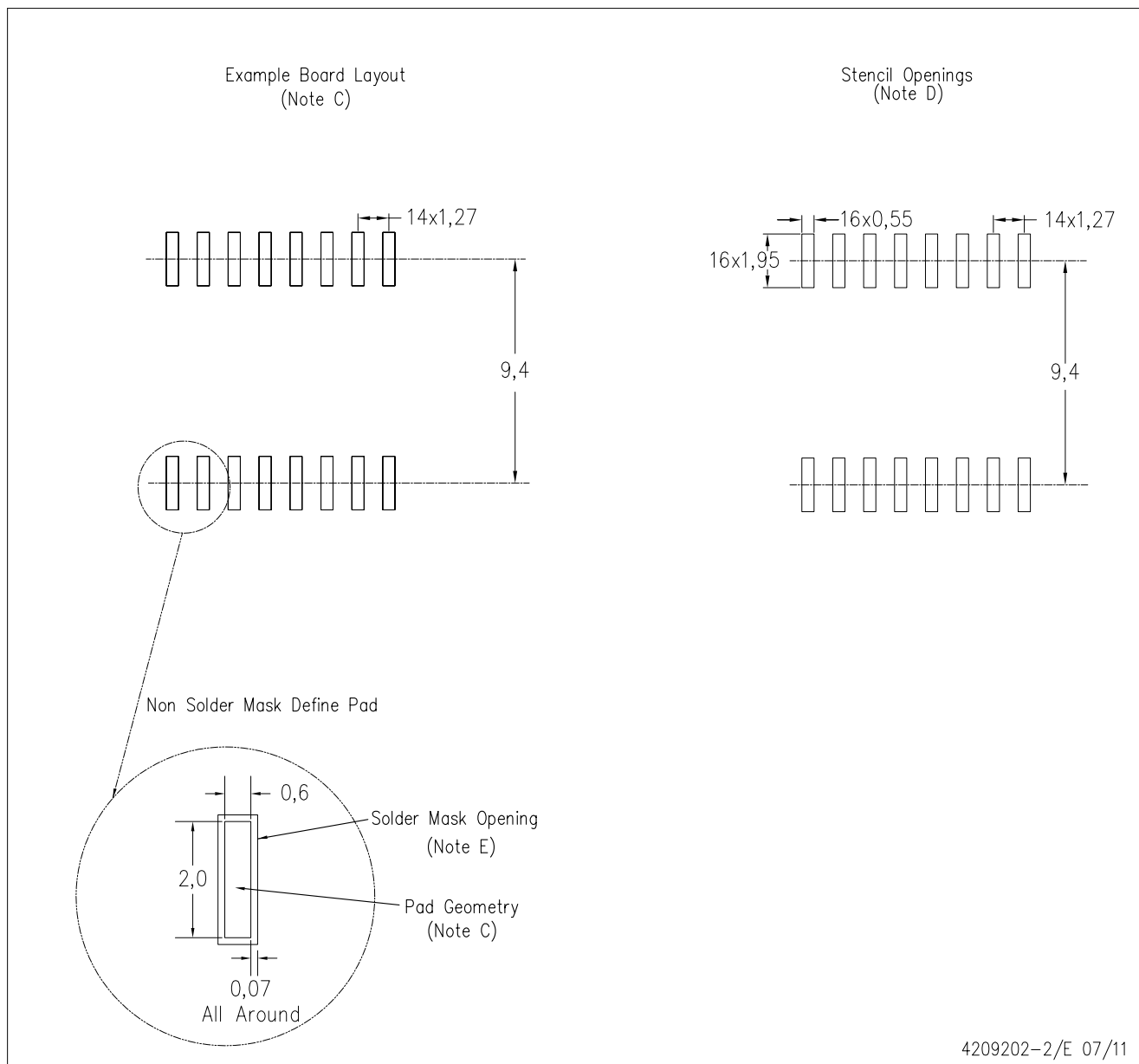
## PLASTIC SMALL OUTLINE



- NOTES: A. All linear dimensions are in inches (millimeters). Dimensioning and tolerancing per ASME Y14.5M-1994.  
B. This drawing is subject to change without notice.  
C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).  
D. Falls within JEDEC MS-013 variation AA.

DW (R-PDSO-G16)

PLASTIC SMALL OUTLINE



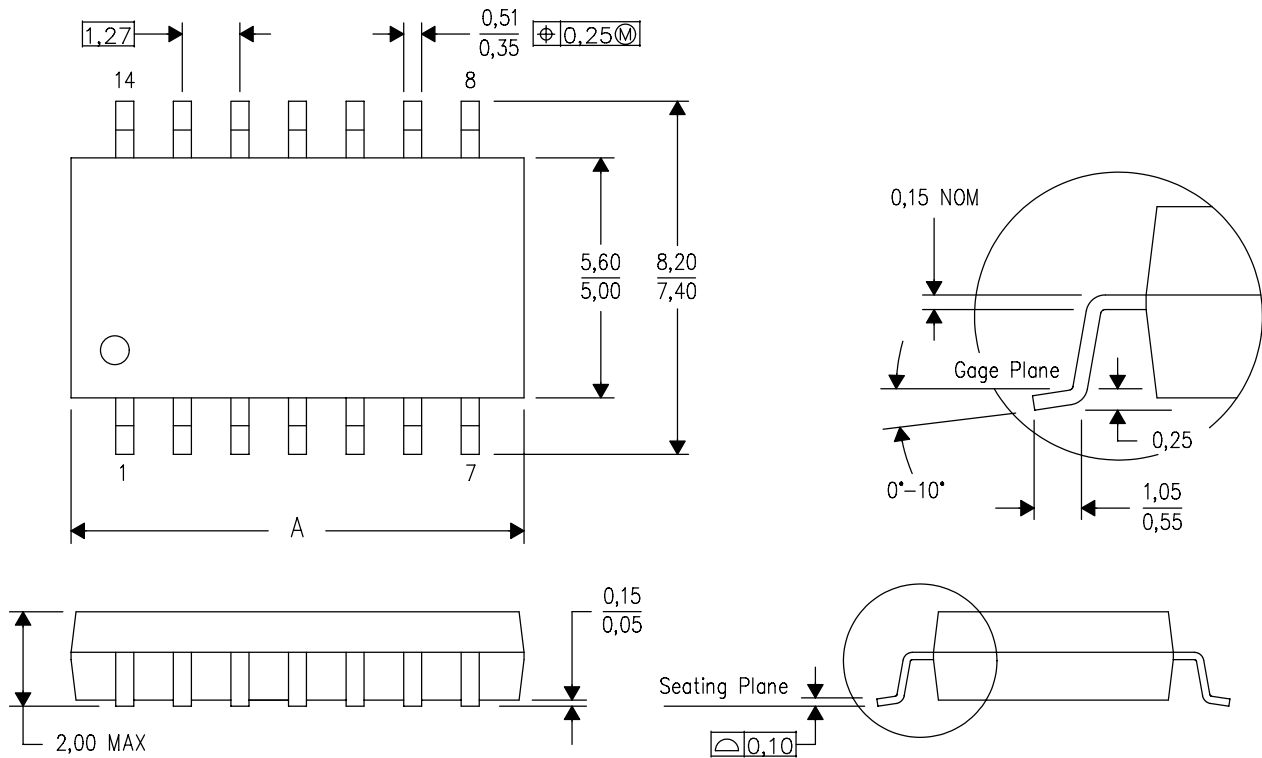
- NOTES:
- A. All linear dimensions are in millimeters.
  - B. This drawing is subject to change without notice.
  - C. Refer to IPC7351 for alternate board design.
  - D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525
  - E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.

# MECHANICAL DATA

NS (R-PDSO-G\*\*)

PLASTIC SMALL-OUTLINE PACKAGE

14-PINS SHOWN



| DIM \ PINS ** | 14    | 16    | 20    | 24    |
|---------------|-------|-------|-------|-------|
| A MAX         | 10,50 | 10,50 | 12,90 | 15,30 |
| A MIN         | 9,90  | 9,90  | 12,30 | 14,70 |

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- NOTES:
- A. All linear dimensions are in millimeters.
  - B. This drawing is subject to change without notice.
  - C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.

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| DLP® Products                | <a href="http://www.dlp.com">www.dlp.com</a>                                         |
| DSP                          | <a href="http://dsp.ti.com">dsp.ti.com</a>                                           |
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| RFID                         | <a href="http://www.ti-rfid.com">www.ti-rfid.com</a>                                 |
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|                               |                                                                                          |
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| Consumer Electronics          | <a href="http://www.ti.com/consumer-apps">www.ti.com/consumer-apps</a>                   |
| Energy and Lighting           | <a href="http://www.ti.com/energy">www.ti.com/energy</a>                                 |
| Industrial                    | <a href="http://www.ti.com/industrial">www.ti.com/industrial</a>                         |
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